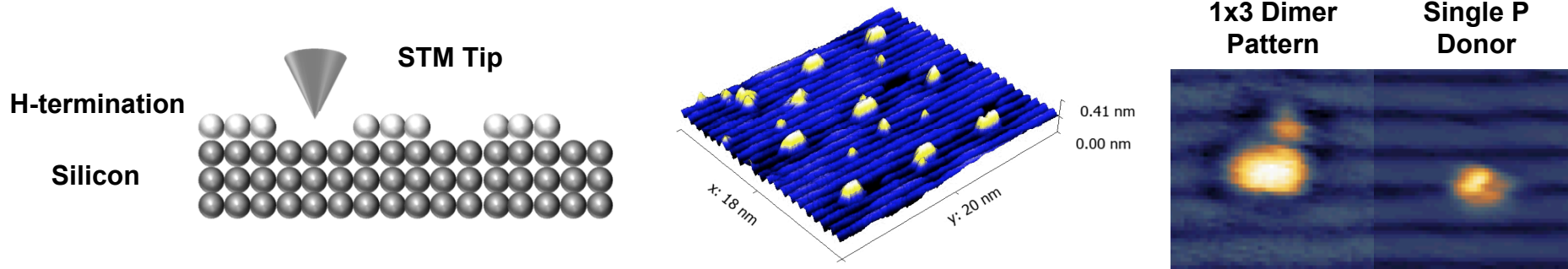


Exceptional service in the national interest



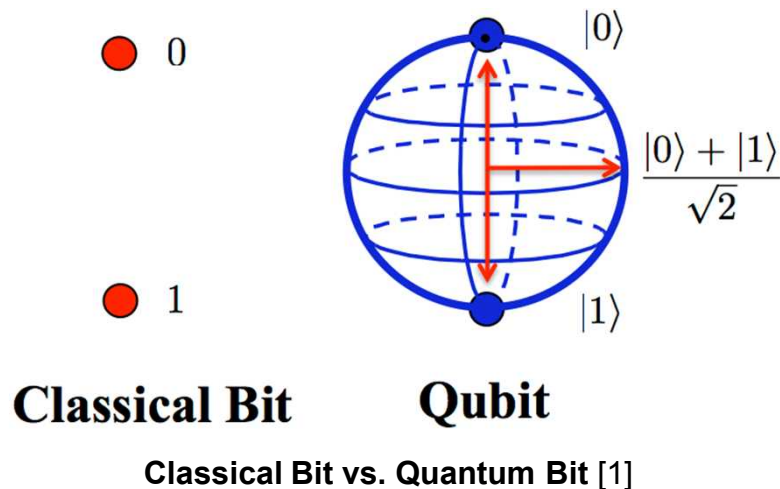
Atomically Precise Single Donor Placement by STM Lithography

J. Koepke (jkoepke@sandia.gov), D. Scrymgeour, R.J. Simonson, M. Marshall, D. Ward, R. Muller, P. Schultz, A. Baczewski, M. S. Carroll, S. Misra, E. Bussmann
Sandia National Labs, Albuquerque, New Mexico, USA

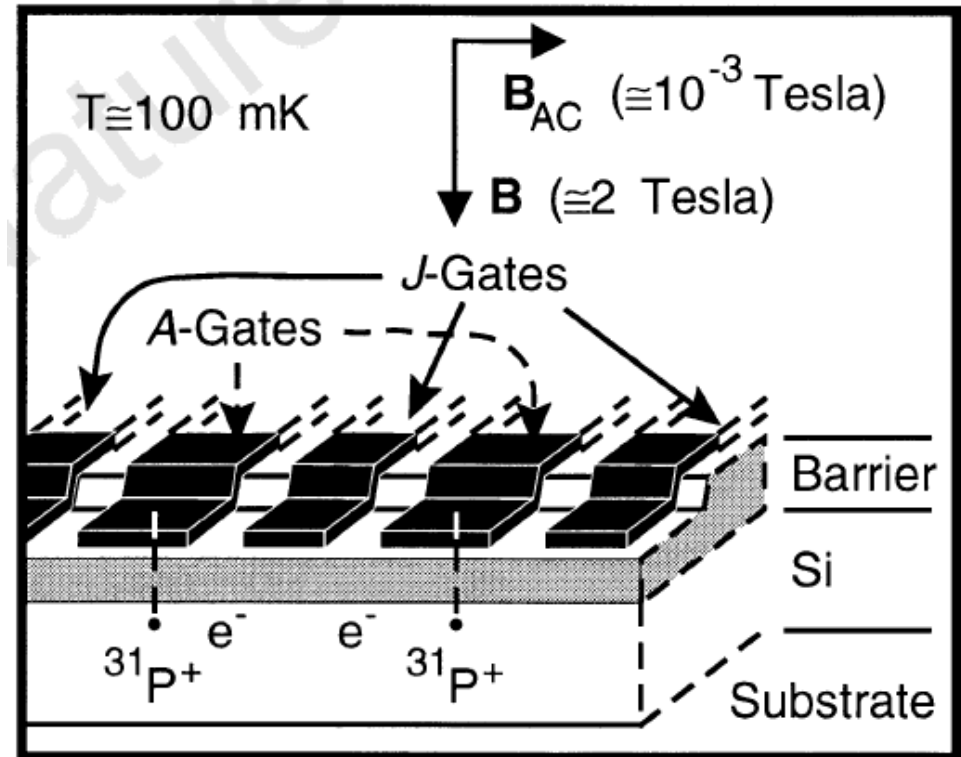
2016 CINT User Meeting

- Motivation for Single P Donors in Si
- Donor Placement by STM Hydrogen Lithography
- Limitations to Donor Placement Yield
- Lithographic Arrays – Improving Target Pattern Yield
- Chemistry of P Donor Incorporation – Comparison of Experiment with Simulations

Single Donors in Si for Quantum Bits



Kane Quantum Computing Architecture [2]



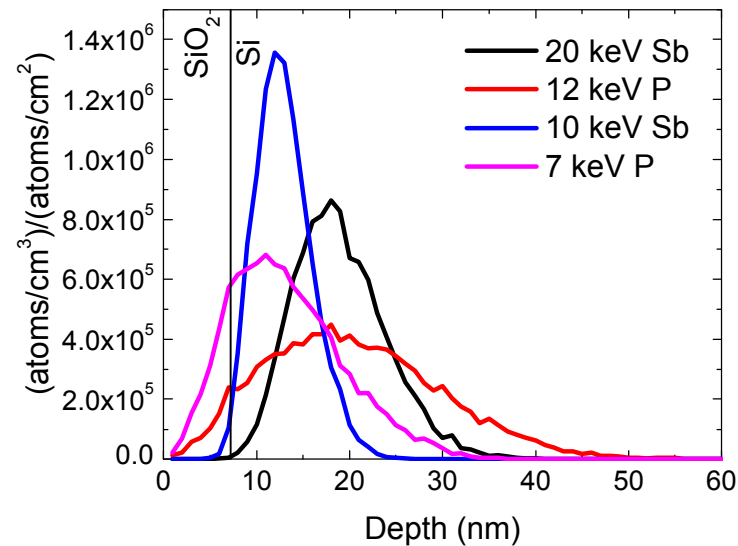
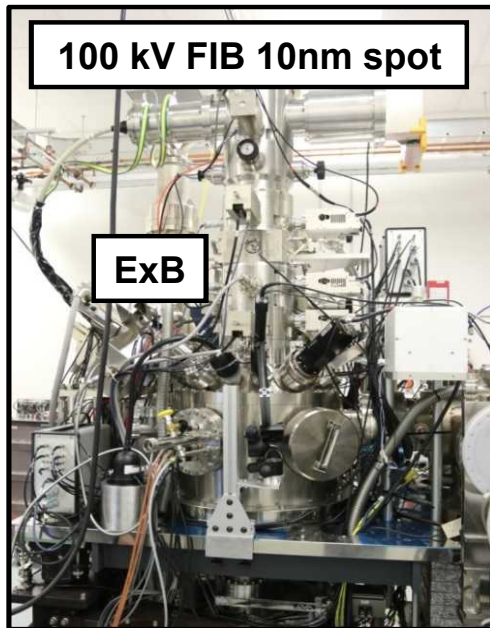
- Si environment allow leverage of vast existing fabrication capability
 - Si substrate shields qubit from spin and charge: “semiconductor vacuum” [2]
- P Donors in Si have very long spin coherence times [3]
 - ^{31}P nuclear spin coherence time $> 30 \text{ s}$
 - e^- spin coherence time $> 0.5 \text{ s}$

[1] http://qogms.phys.strath.ac.uk/research_gc.html [2] Kane, *Nature*, **393** (1998);

[3] Steger, *Science*, **336** (2012); [4] Muhonen, *Nat. Nano.*, **9** (2014)

Routes to Single Donors in Si

Ion Implantation

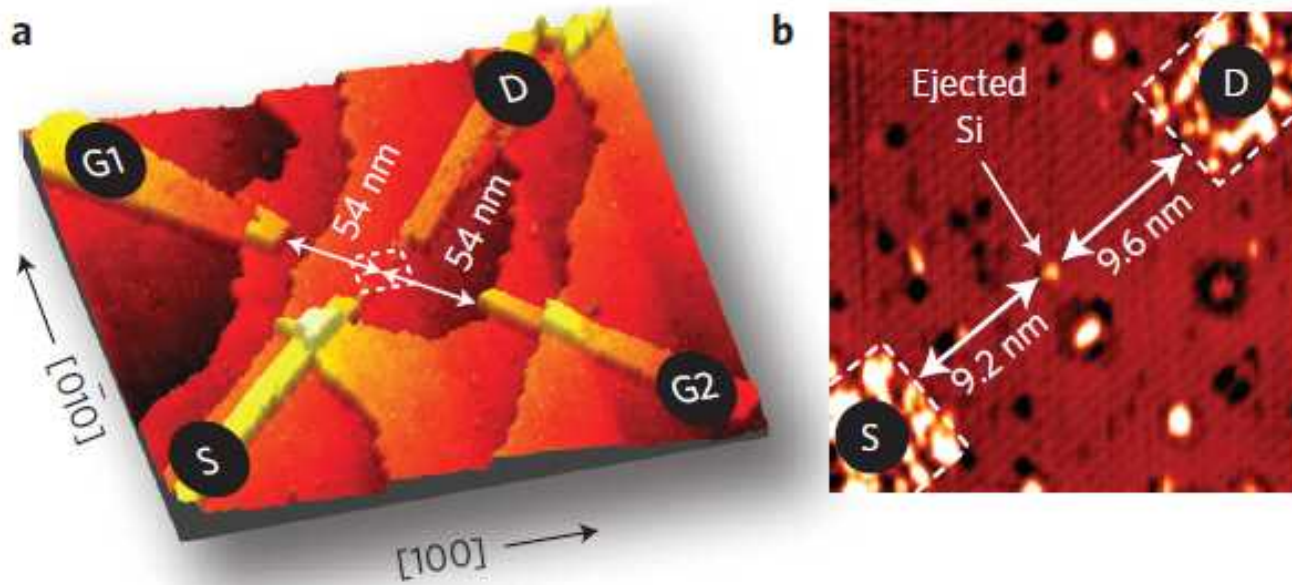


Provided courtesy of Bielejec (Sandia National Laboratories)

- Straggle: Significant uncertainty in donor placement

Atomically Precise Donor Placement

Single Atom Transistor

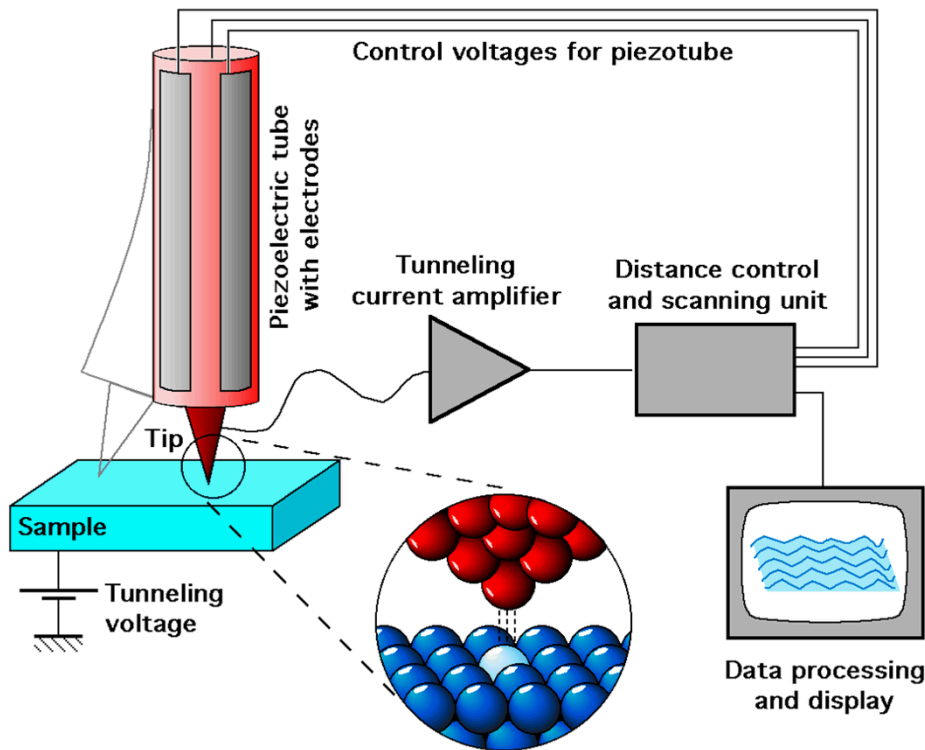


Fuechsle, *Nat. Nano.*, 7 (2012)

- Simmons' group (UNSW) has demonstrated atomically precise donor placement for device fabrication

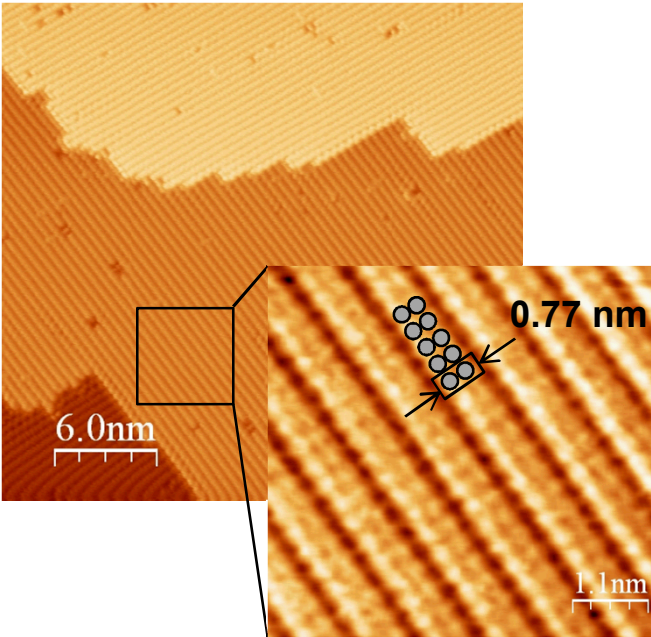
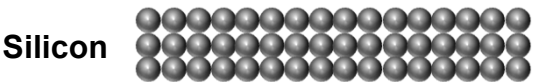
Scanning Tunneling Microscopy

STM Schematic



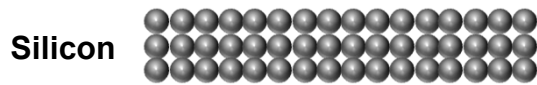
By Michael Schmid - Michael Schmid, TU Wien; adapted from the IAP/TU Wien STM Gallery, CC BY-SA 2.0 at, <https://commons.wikimedia.org/w/index.php?curid=180388>

Si(100) – 2×1 Surface



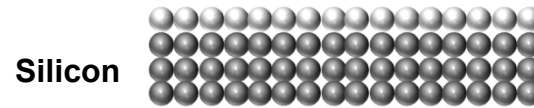
STM Hydrogen Lithography

Si(100) – 2×1:H Surface

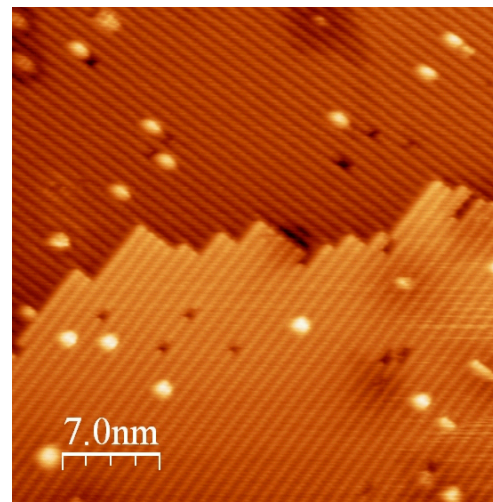
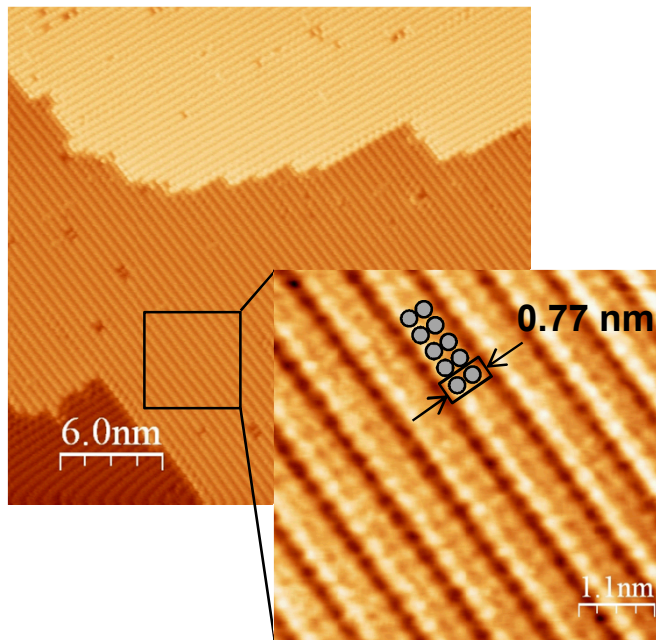
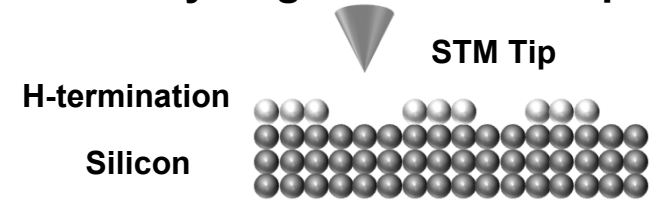


Si(100) – 2×1:H Surface

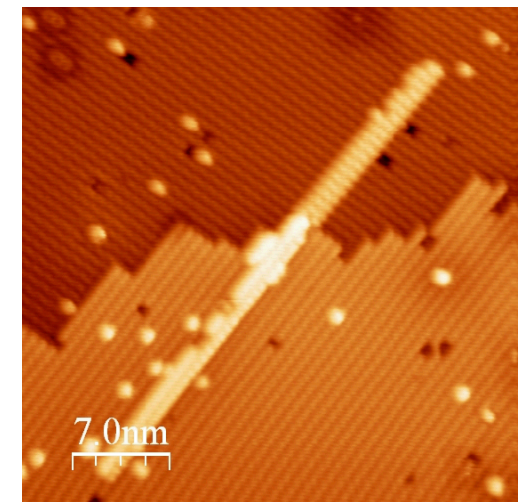
H-termination



Remove Hydrogen with STM Tip



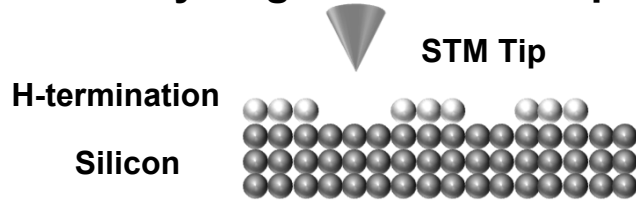
Dark spots are missing Si atoms.
Bright spots are missing H atoms



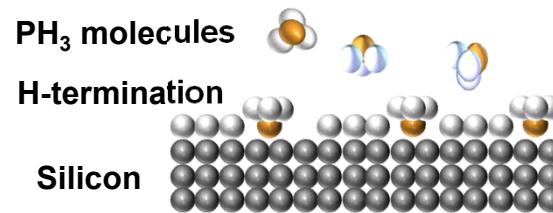
Can selectively remove H from the Si(100) – 2×1:H Surface using the STM tip 7

Donor Placement by STM Hydrogen Litho

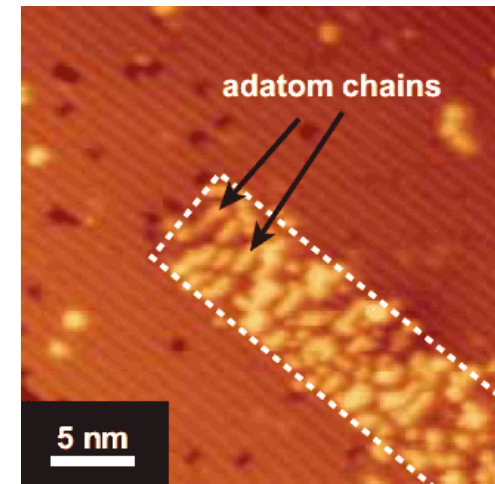
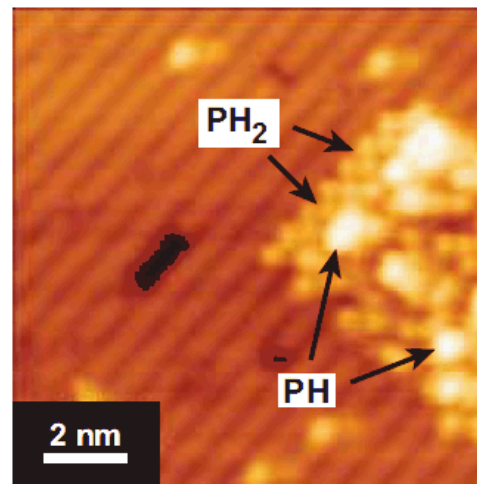
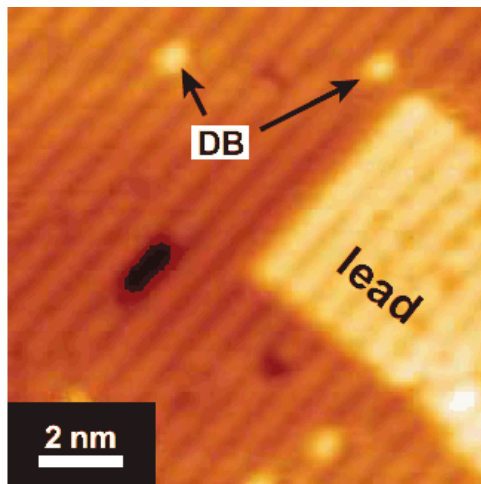
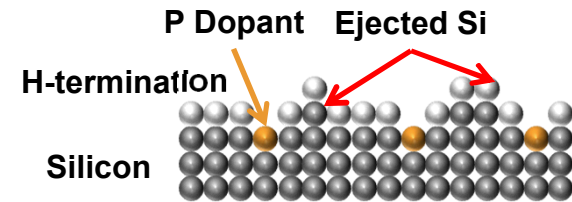
Remove Hydrogen with STM Tip



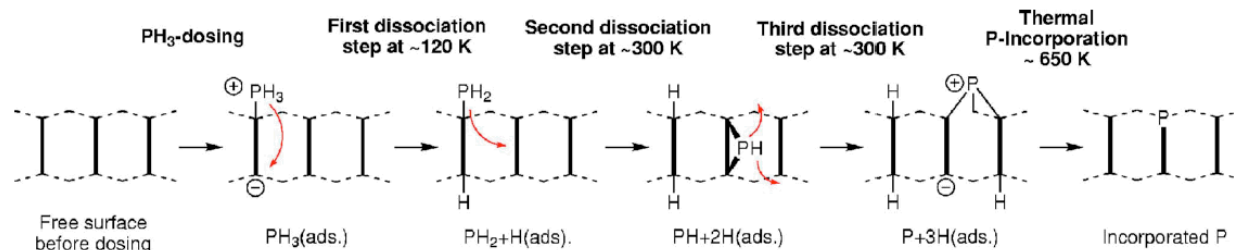
Dose sample with PH_3



Incorporate P Dopants



[1] Fuechsle, *Ph.D. Dissertation* (2011)



[2] Wilson, *Phys. Rev. B*, **74** (2006)

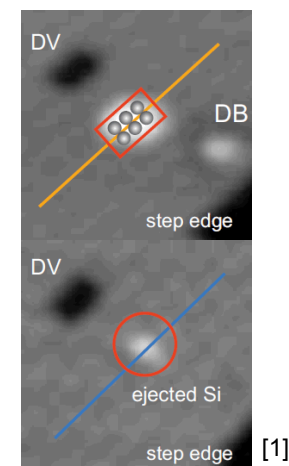
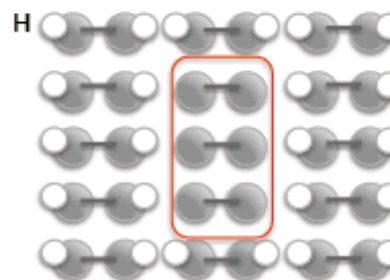
Substitutional incorporation of P donors from PH_3 is a thermally activated process 8

Factors Limiting Single Donor Placement Yield

$$\text{Single Donor Yield} = \text{Litho Yield} \times \text{Chemistry Process Yield}$$

- STM Lithographic Pattern Size
 - Highest reported *single* donor yield for 1x3 dimer lithography patterns [1].

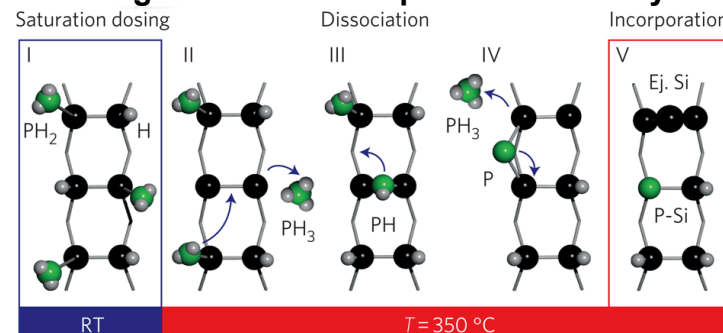
**Target Litho Pattern
Size: 1x3 Dimers**



[1]

- Chemical Pathway
 - Reported 70% yield for single donors in 1x3 dimer patterns [1]

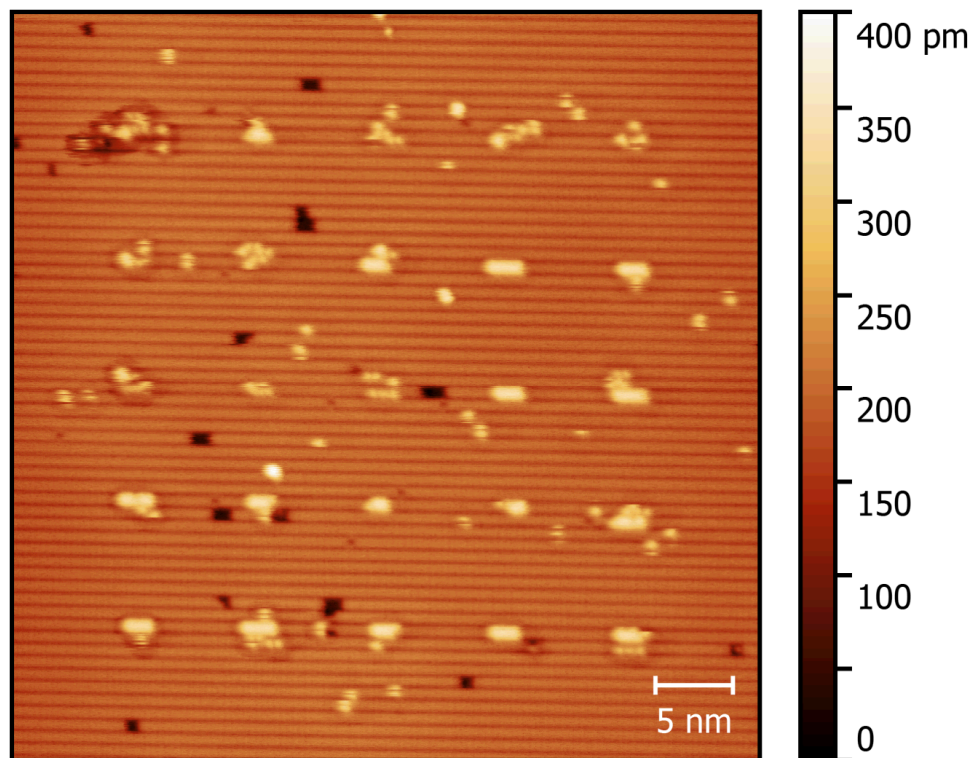
Single P Donor Incorporation Pathway



[2] Fuechsle, *Nat. Nano.*, 7 (2012)

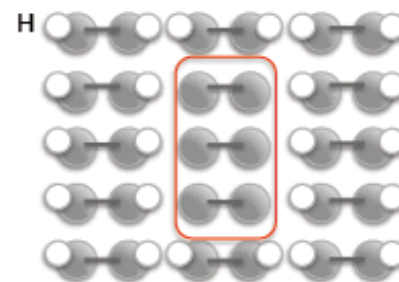
[1] Fuechsle, *Ph.D. Dissertation* (2011)

Lithography at Few Atom Limit



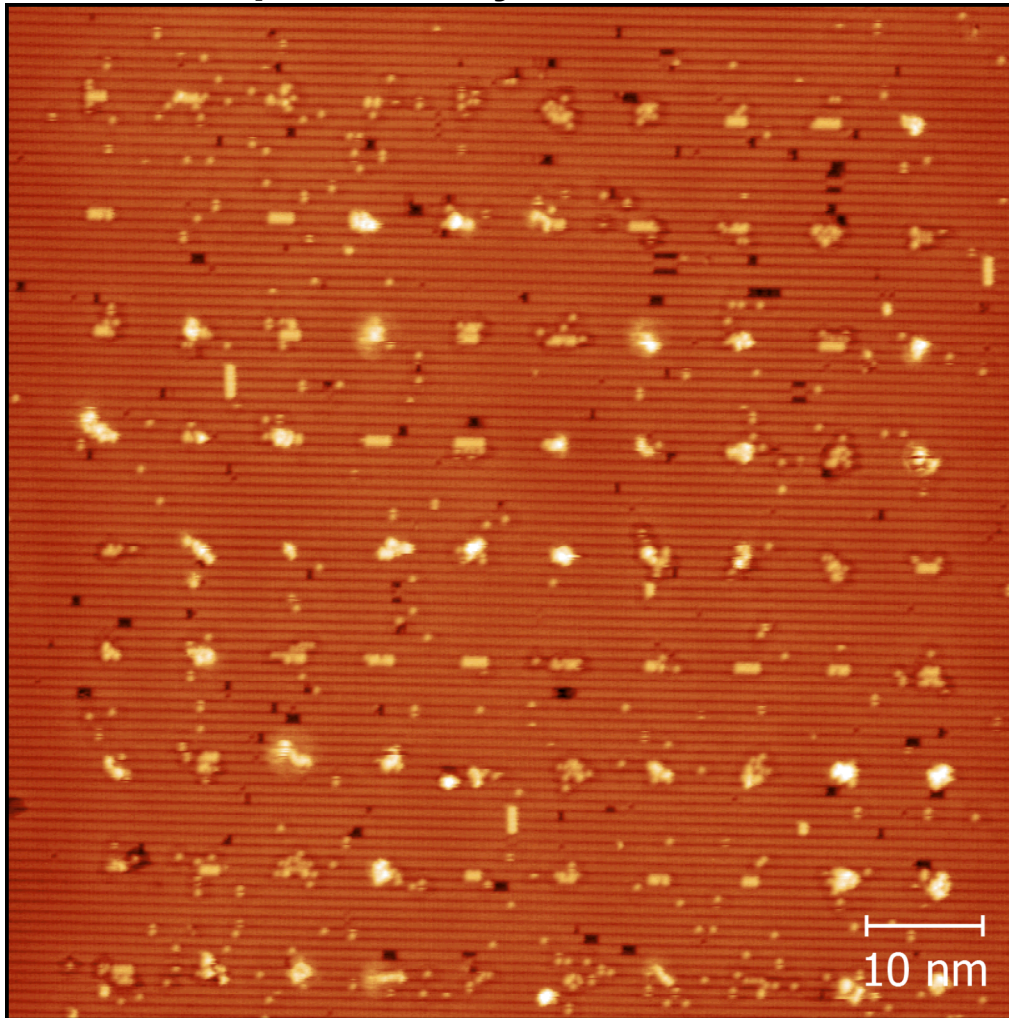
Only 20% of Litho Sites Single Row

Target Litho Array
Element: 1x3 Dimers

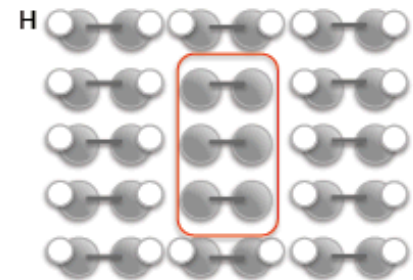


- Examine lithography statistics
- Factors affecting litho yield:
 - STM tip sharpness & stability
 - Litho Process Parameters

Effect of Tip Instability



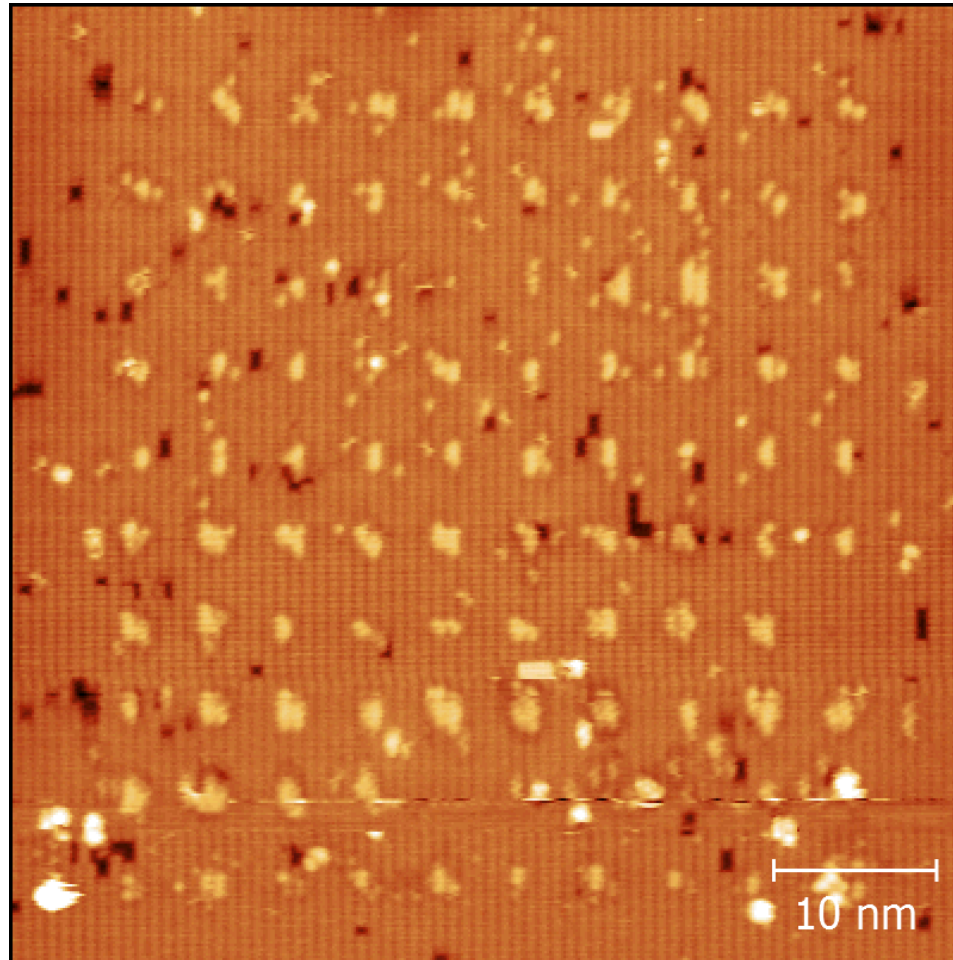
Target Litho Array
Element: 1x3 Dimers



Unstable tips: (1) drop material during patterning
(2) give disordered lithographic patterns

Effect of Tip Alignment to Dimer Rows

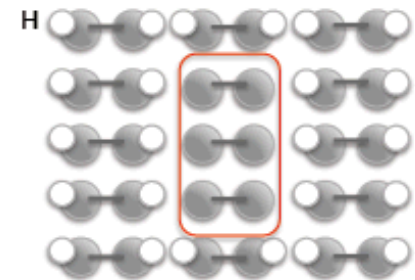
Litho Sites Intentionally Rotated 45° from Alignment with Dimer Rows



Only 10% of Litho Sites Single Row

Data collected by R. Butera (LPS)

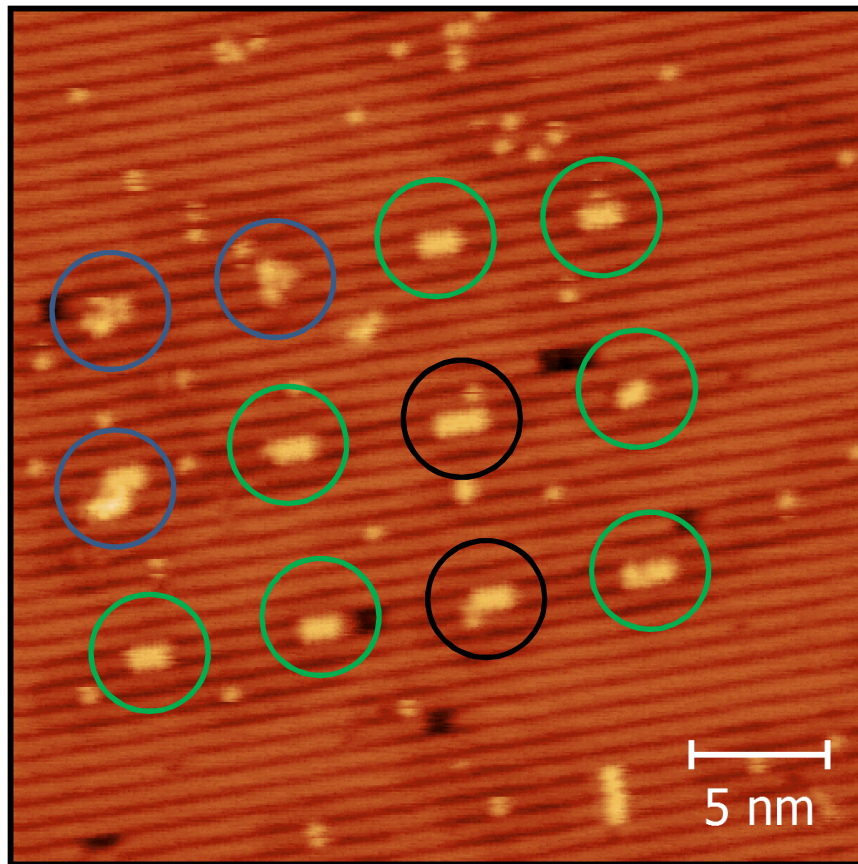
Target Litho Array
Element: 1x3 Dimers



Lithographic Arrays – Better Alignment

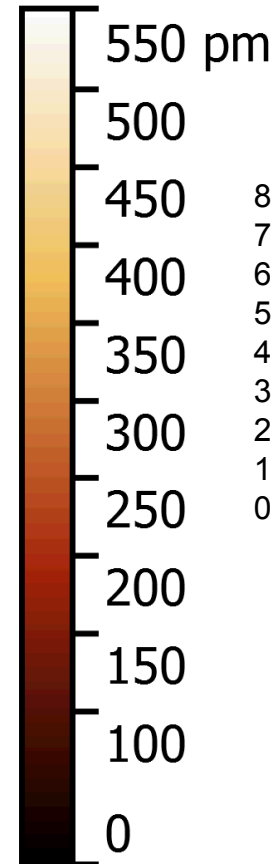
Steps to improve litho yield:

- (1) Reduce Array Size to Improve Alignment to Dimer Rows
- (2) Consistent Tip Preparation

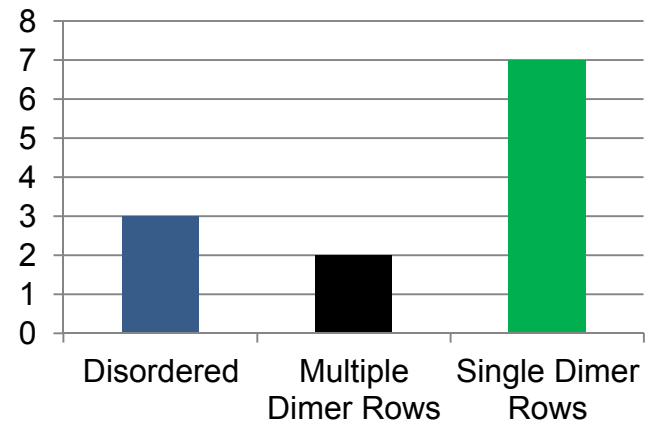


Litho Feature Legend:

- Disordered Features
- Multiple Dimer Row Features
- Single Dimer Row Features

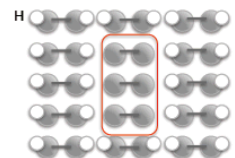


Array Element Alignment



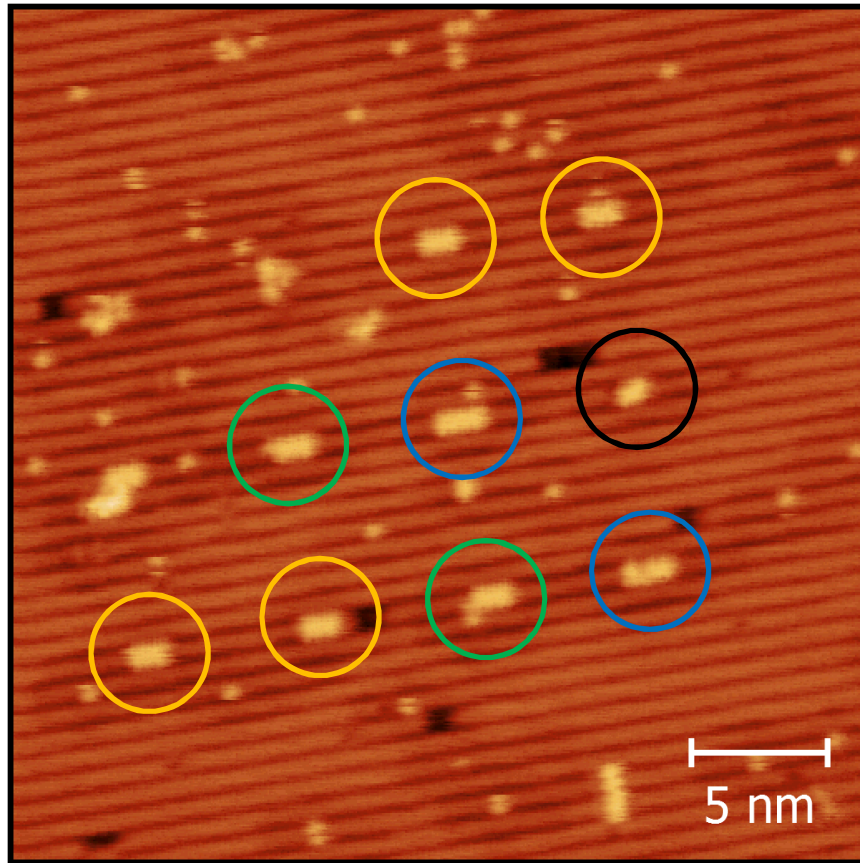
Single Dimer Row Yield: 7/12

Target Litho Array
Element: 1x3 Dimers



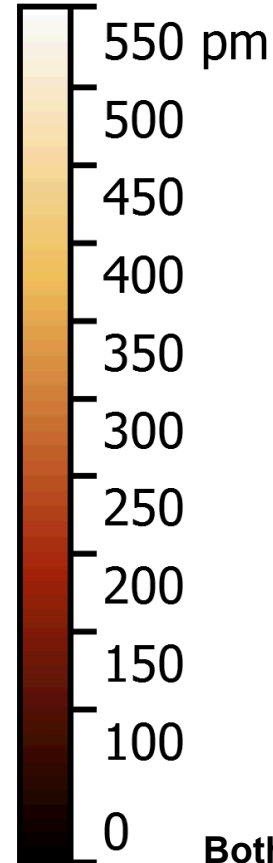
Lithographic Arrays – Better Yield

Reduced Array Size and Consistent Tip Preparation

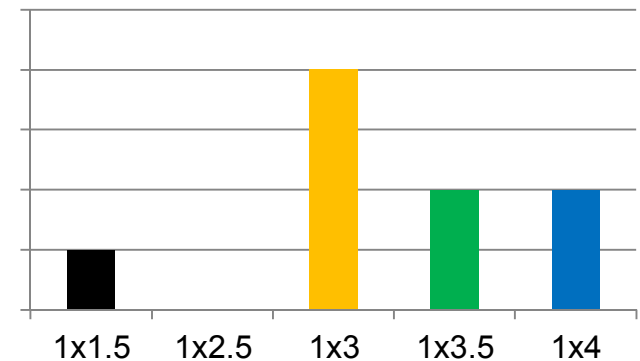


Litho Feature Legend:

- 1x1.5 Dimers
- 1x2.5 Dimers
- 1x3 Dimers
- 1x3.5 Dimers
- 1x4 Dimers

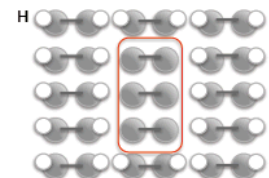


Single Dimer Row Pattern Length (Dimers)



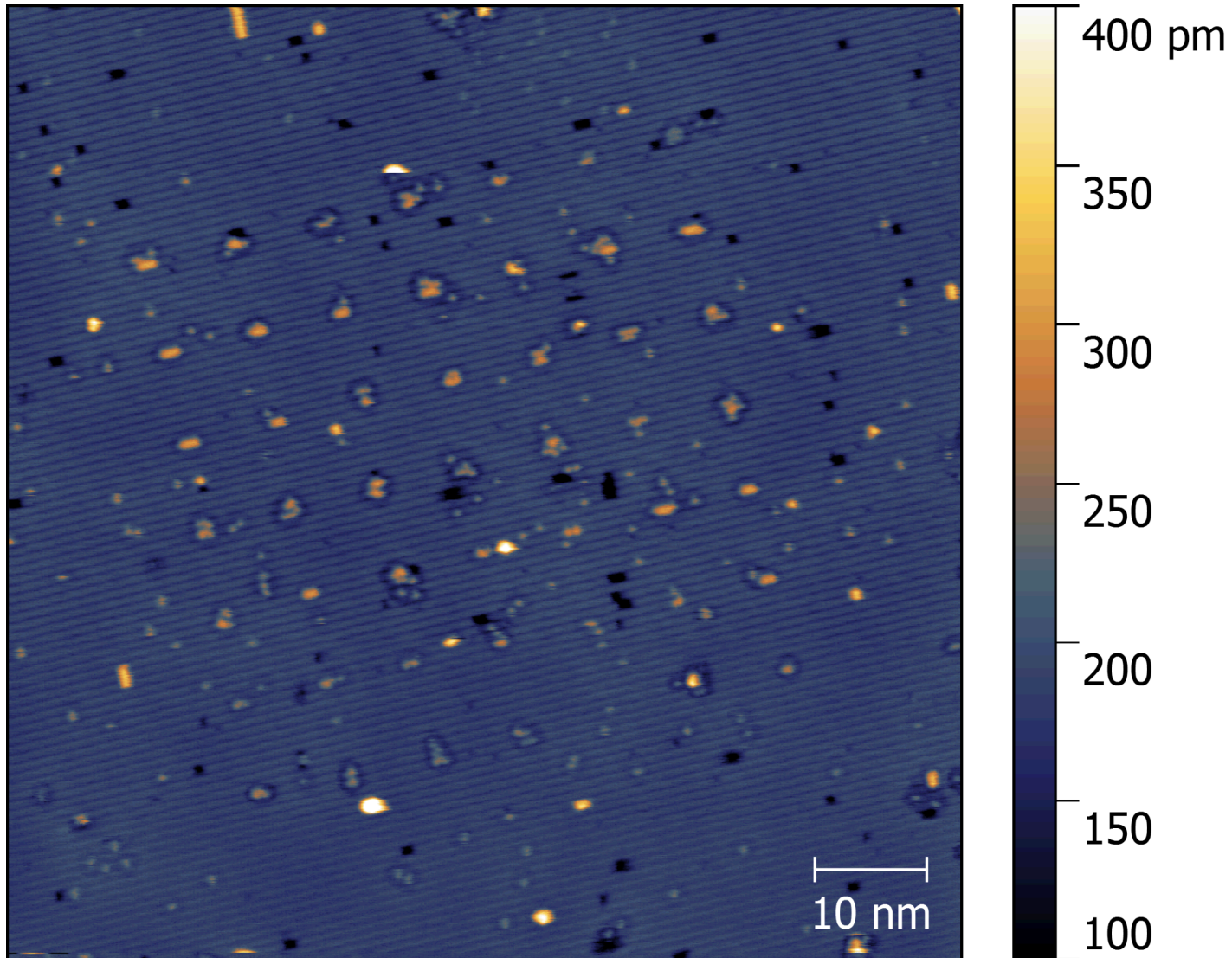
Yield of 1x3 Dimer Patterns: 4/12
Both 1x3 and 1x3.5 Dimer Patterns: 6/12

Target Litho Array
 Element: 1x3 Dimers

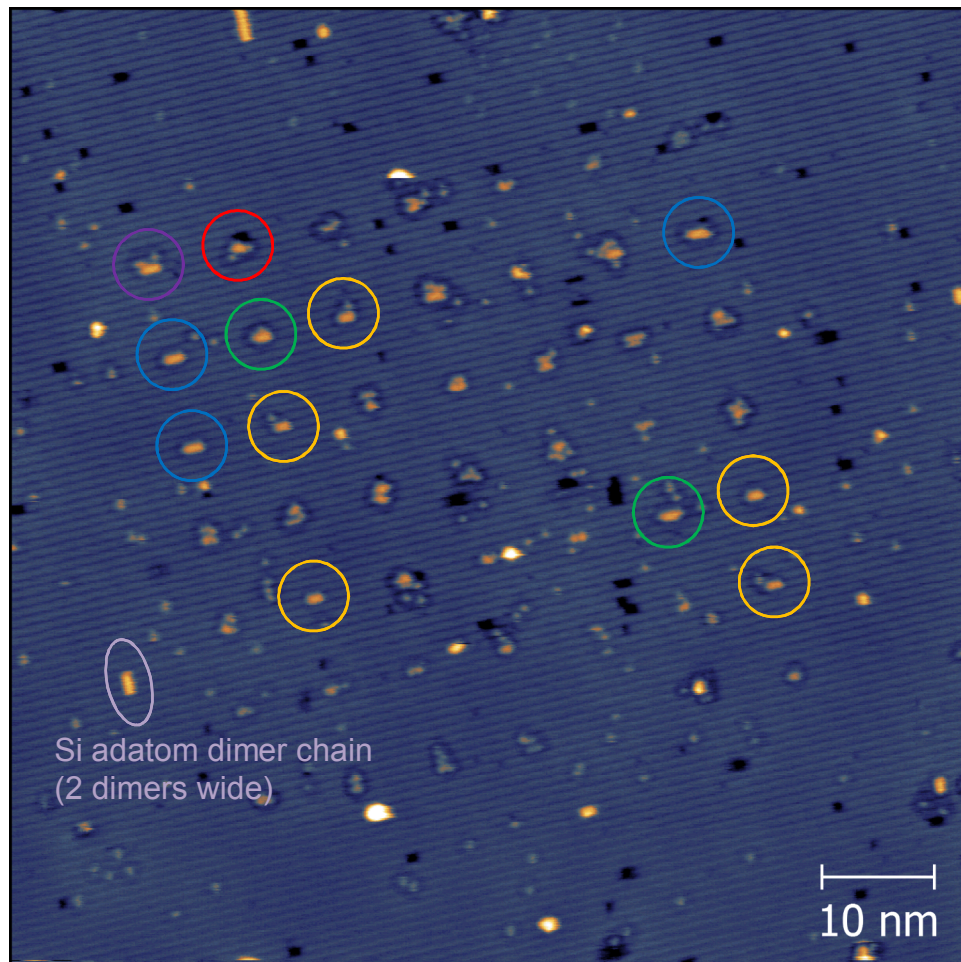


P Donor Incorporation in Lithographic Arrays

7x7 Litho Array



P Donor Incorporation in Lithographic Arrays



1x2.5 Dimers

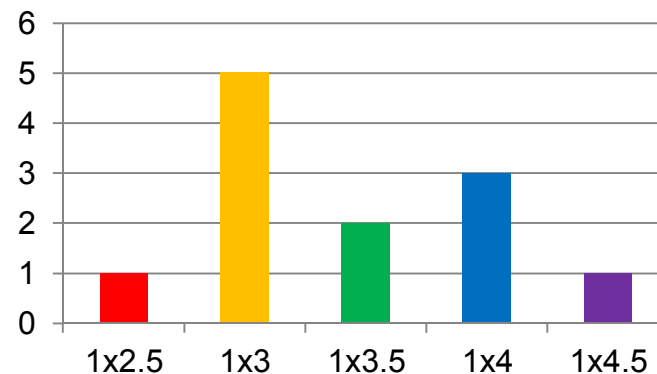
1x3 Dimers

1x3.5 Dimers (extra dangling bond)

1x4 Dimers

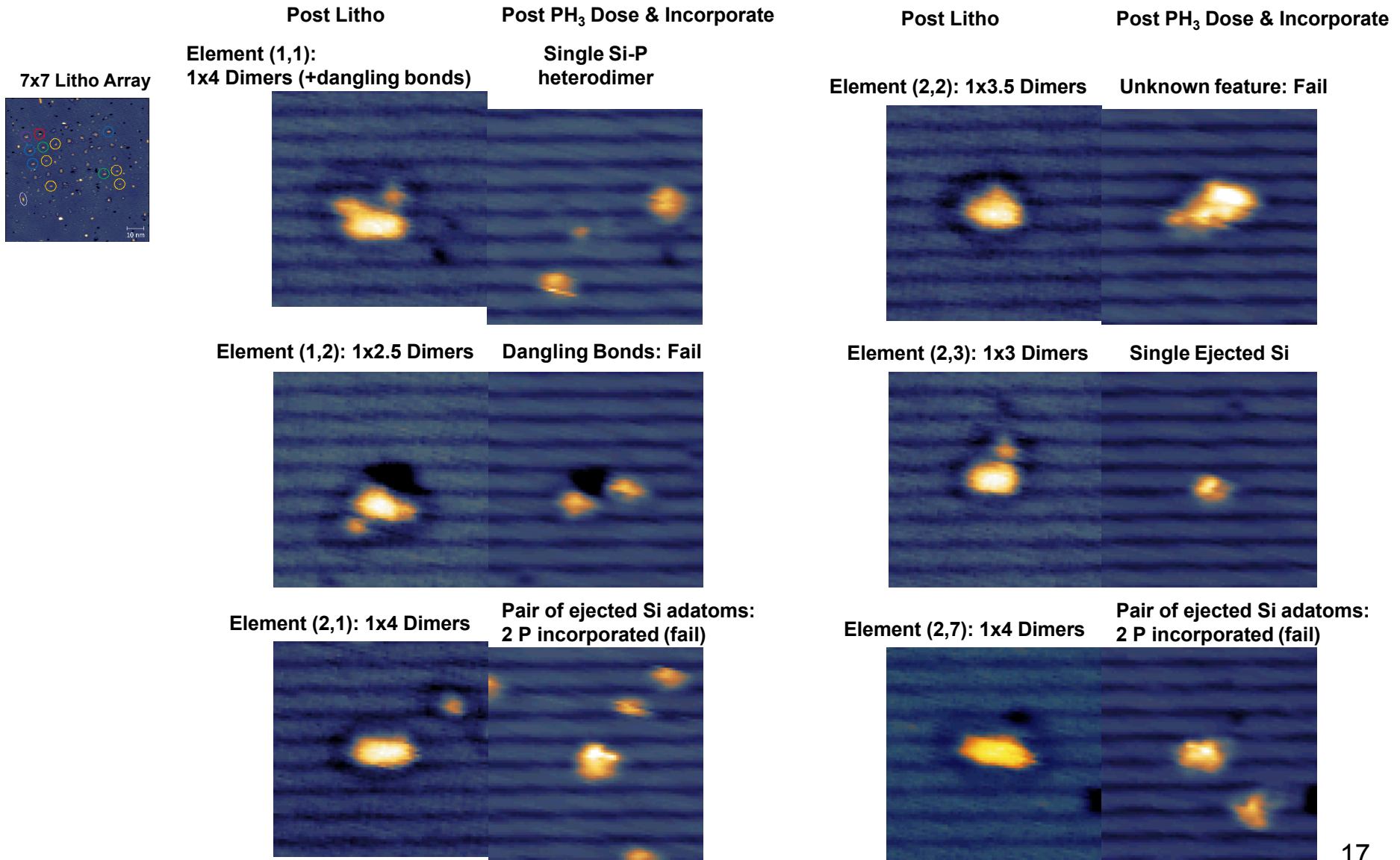
1x4.5 Dimers (extra dangling bonds)

Single Dimer Row Pattern
Length (Dimers)

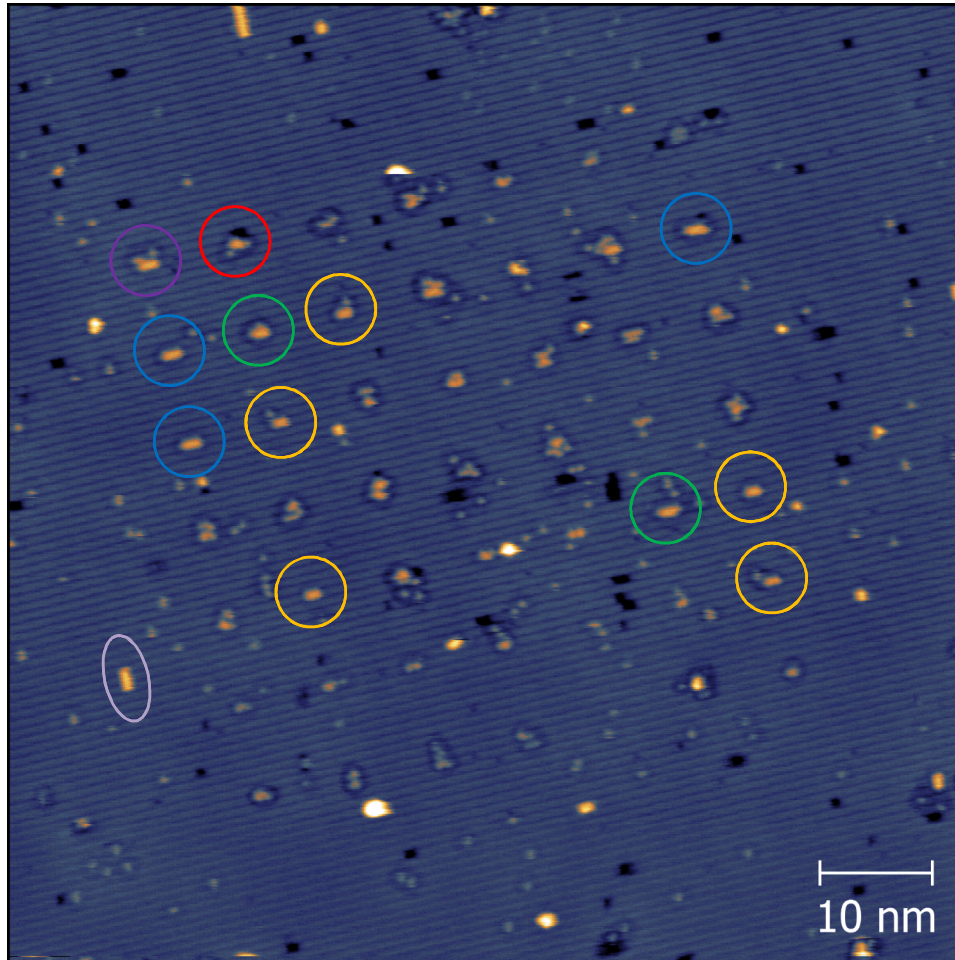


Yield of 1x3 Dimer Patterns: 5/49 (~10%)
Both 1x3 and 1x3.5 Dimer Patterns: 7/49 (~15%)

Analysis of P Donor Incorporation in Arrays



P Donor Yield in Lithographic Arrays



1x2.5 Dimers

1x3 Dimers

1x3.5 Dimers (extra dangling bond)

1x4 Dimers

1x4.5 Dimers (extra dangling bonds)

Incorporation Summary

Single Donor Incorporation:

- (1,1), (2,3), (3,2), (5,6), (5,7)

Double Donor Incorporation:

- (2,1), (2,7), (3,1), (6,7)

Unknown:

- (2,2)

Nothing:

- (1,2), (5,2)

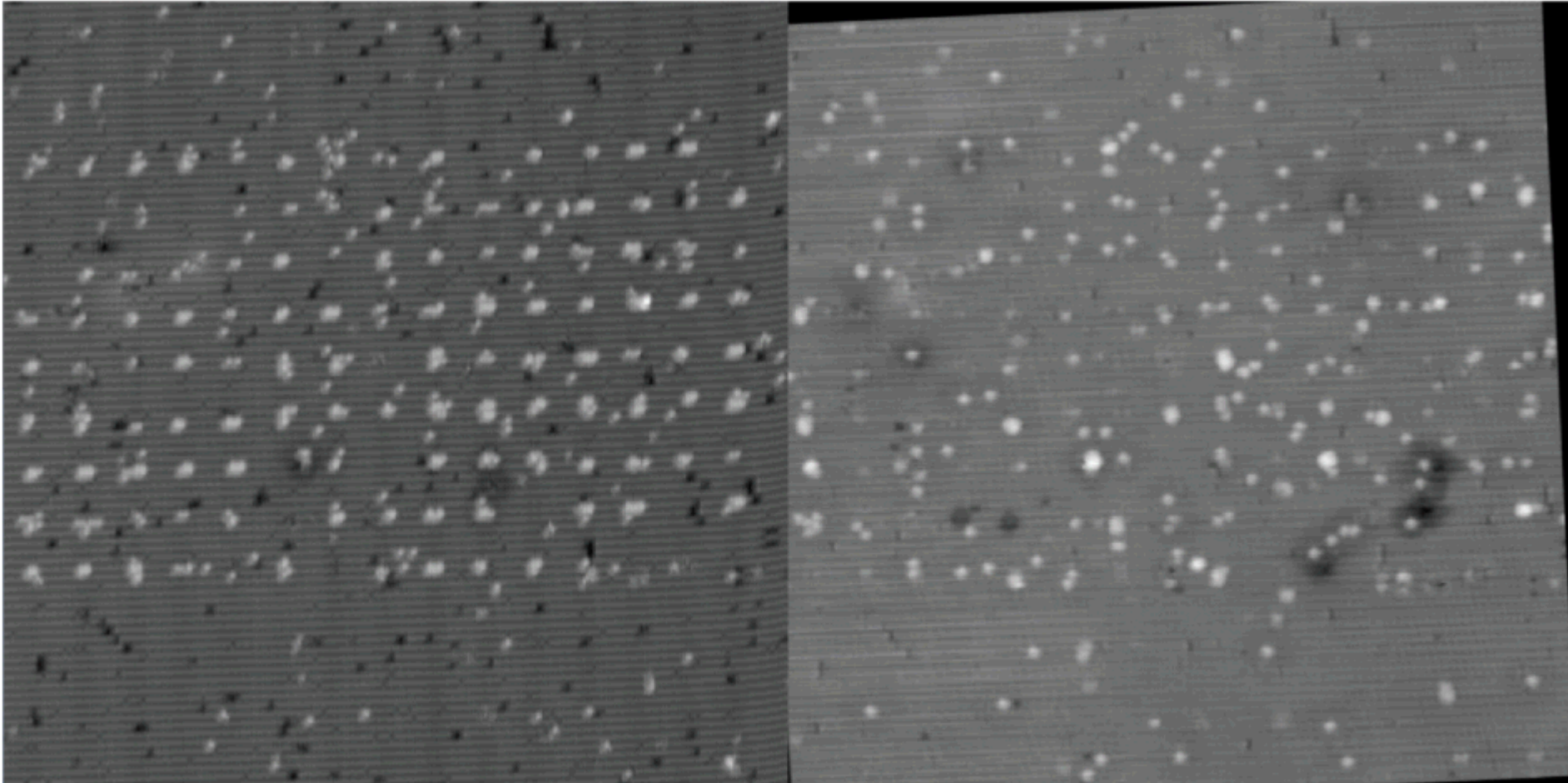
Single P yield for array: ~10% (5/49)

Single P incorporation for only 1x3 dimer sites : 60% (3/5)

Feature Identification for Array Analysis

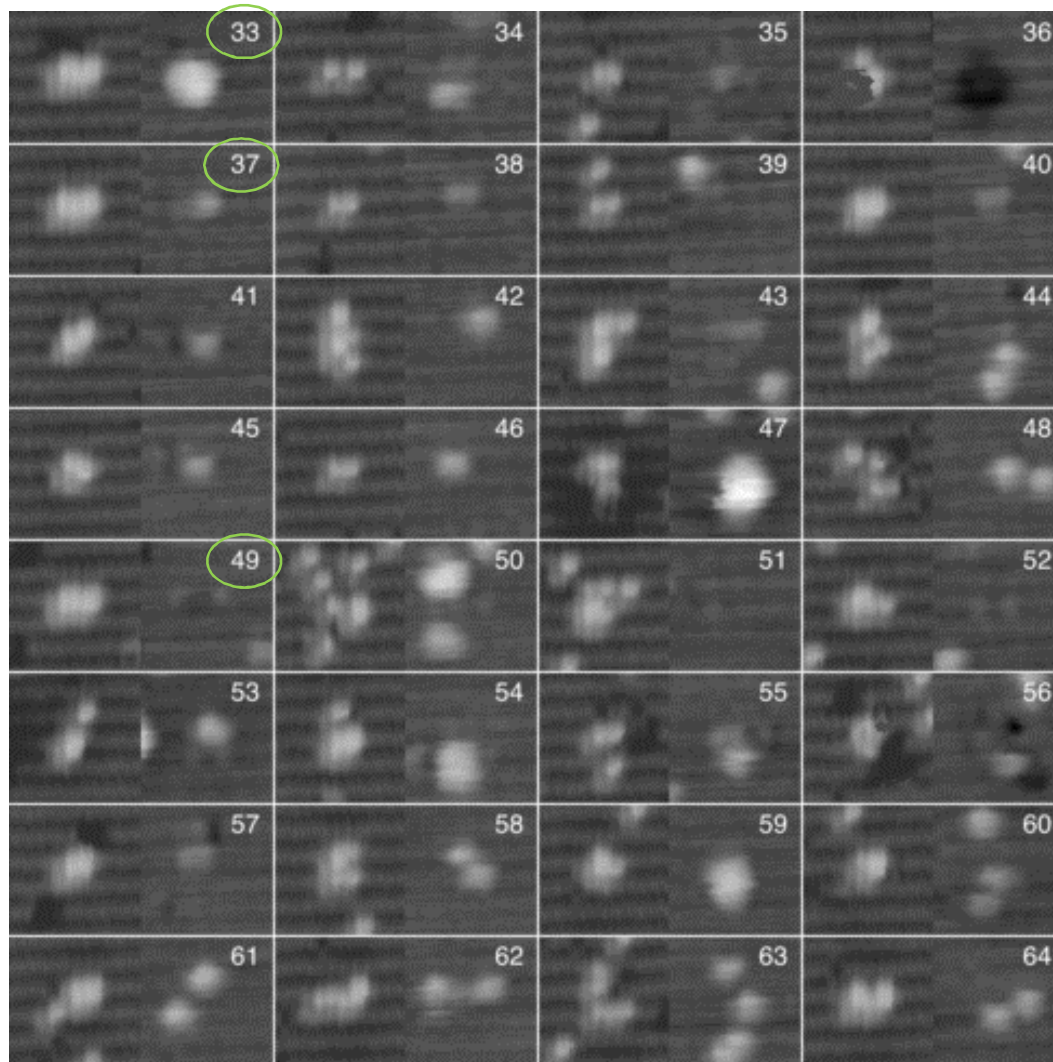
9x15 Lithographic Array, 100 nm x 100 nm

After PH_3 Dose and Incorporation



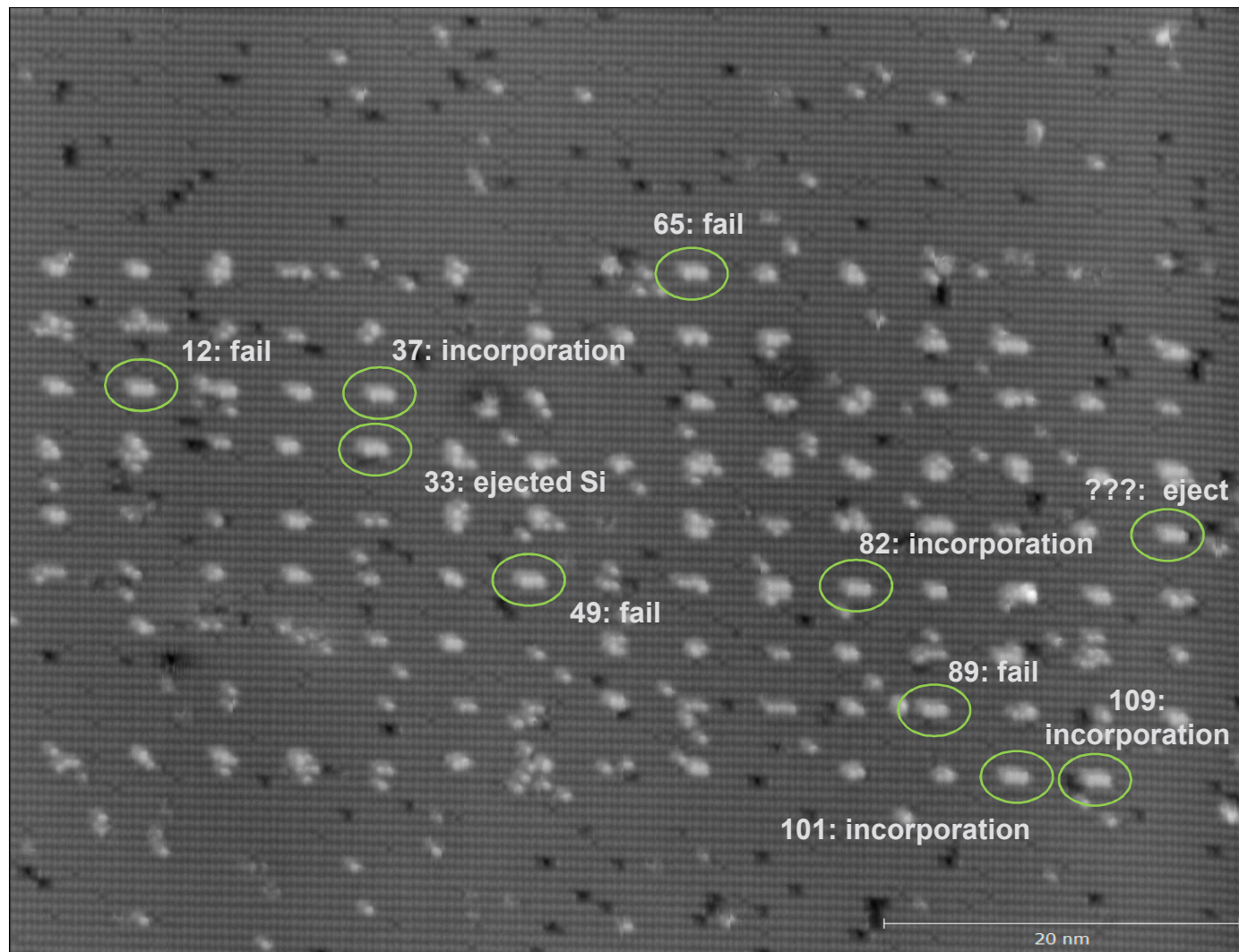
Align scan after lithography and scan after PH_3 dose and incorporation

Feature Identification in Incorporated Arrays



**Compare post-lithography and post PH_3 dose and incorporation.
Did P incorporation happen at the litho sites?**

P Donor Yield in Lithographic Arrays



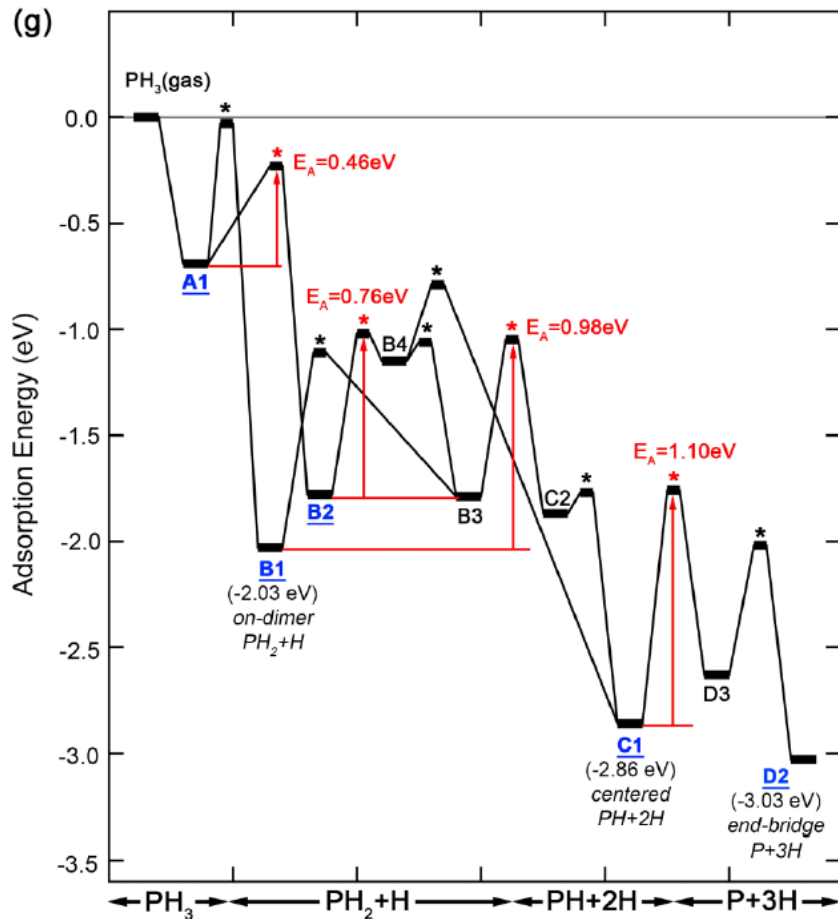
9x15 Litho Array. 10 out of 135 (7%) sites successful 1x3 dimer patches.

7 incorporated 1x3 dimer litho sites out of 135: 5% single donor yield for array.

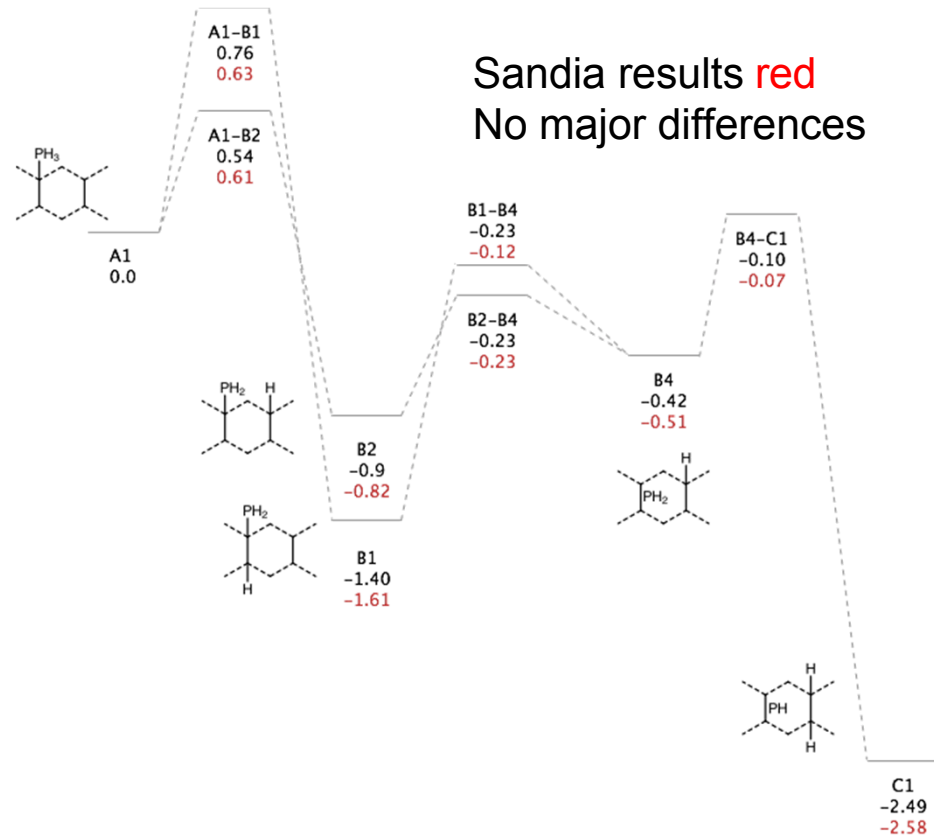
7 incorporated sites out of 10 1x3 dimer litho sites: 70% incorporation in 1x3 dimer patches. 21

Simulations of P Donor Incorporation

Calculated PH_3 Dissociation Reaction Barriers



Warschkow, *J. Chem. Phys.*, 144 (2016)

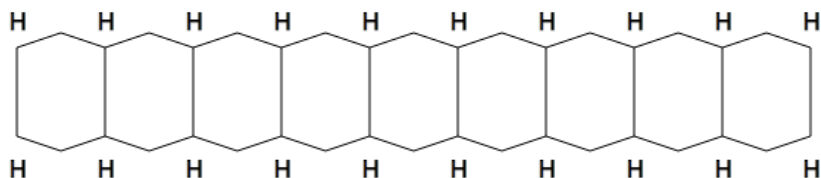


Muller, Schultz, Baczewski (Sandia)

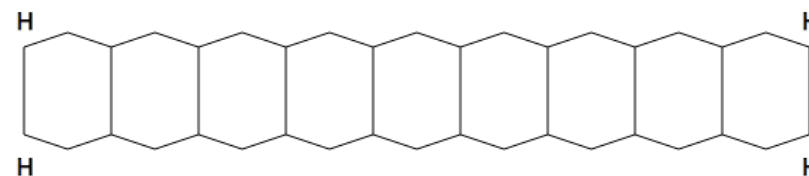
Kinetic Monte Carlo Simulations of P Incorporation

KMC is an algorithm to rapidly sample a chemical mechanism to generate probable resulting product states.

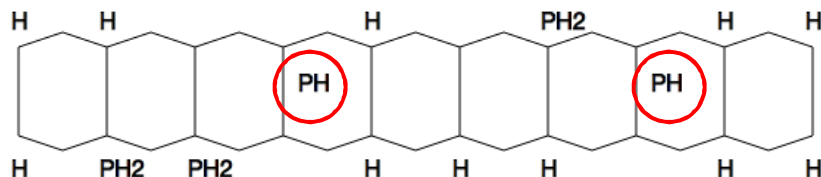
Create a row of N dimers (here N=10)



Depassivate the interior dimers

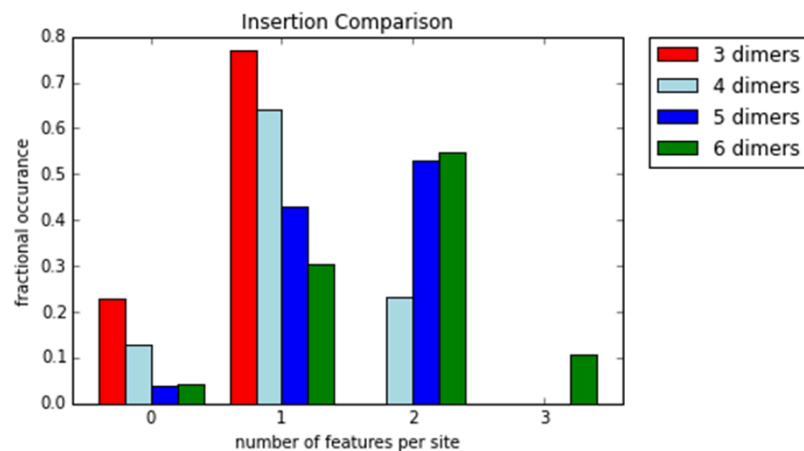
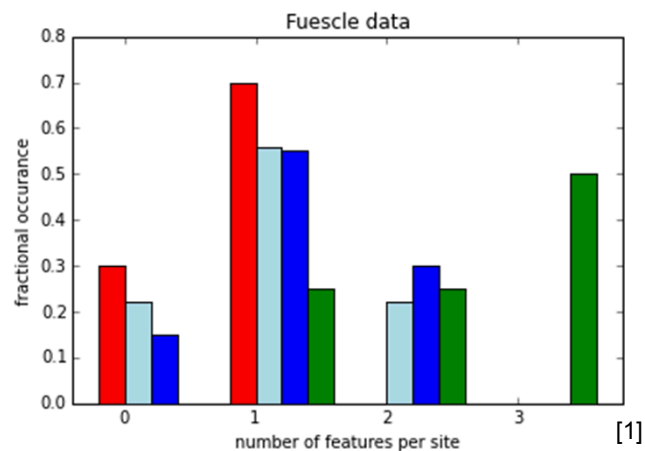


Sample the chemistry until the surface is saturated

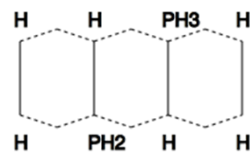
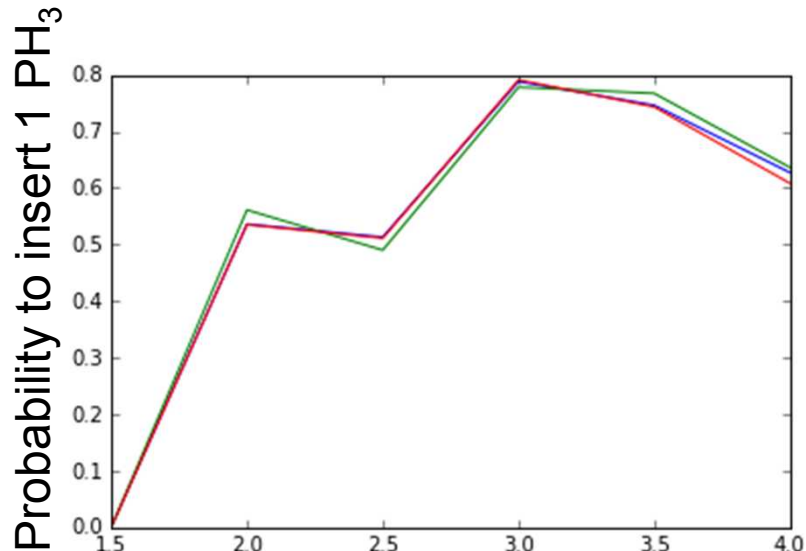


Bridging PH groups lead to P incorporation

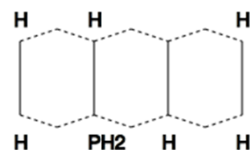
Kinetic Monte Carlo Simulations of P Incorporation in Lithographic Windows



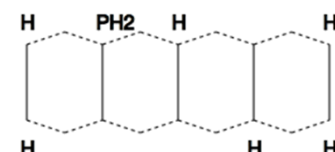
Values for 1x3 dimer lithographic windows similar to our experimental values (0.6 – 0.7).



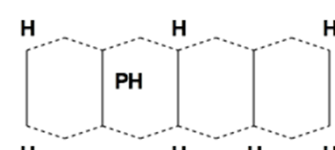
t=0.411



t=0.707



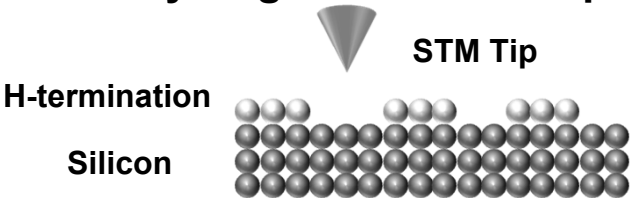
t=0.040



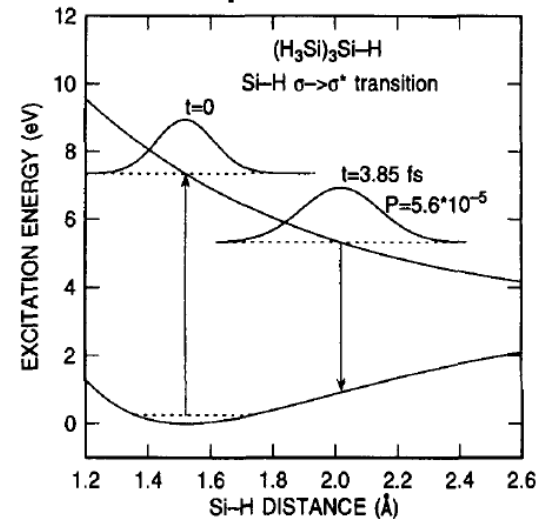
- Demonstrated STM Hydrogen Lithography at length scales necessary for placing single P donors
- Yield of 1x3 dimer patterns initially 0%.
- Increased yield to 10% in large arrays with better tip alignment.
- Better tip alignment for small arrays led to 1x3 dimer pattern yield up to 33%.
- Overall yield of single P donors for Arrays ~5-10%.
- Yield of single P donors only for 1x3 dimer features ~60% – 70%, very close to simulation values and prior experimental data.

STM Hydrogen Lithography Mechanisms

Remove Hydrogen with STM Tip



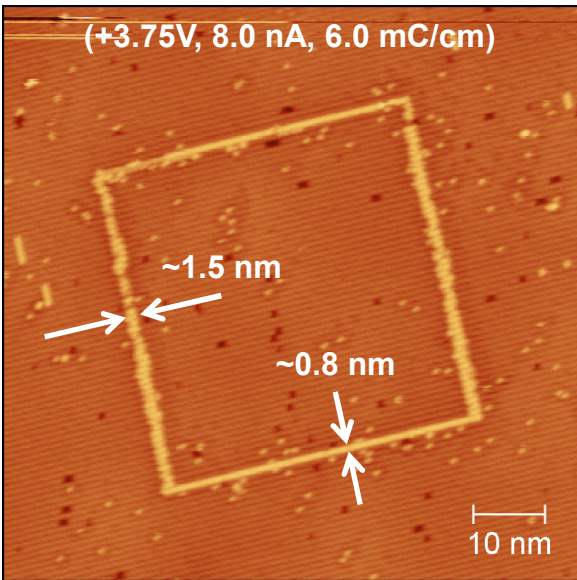
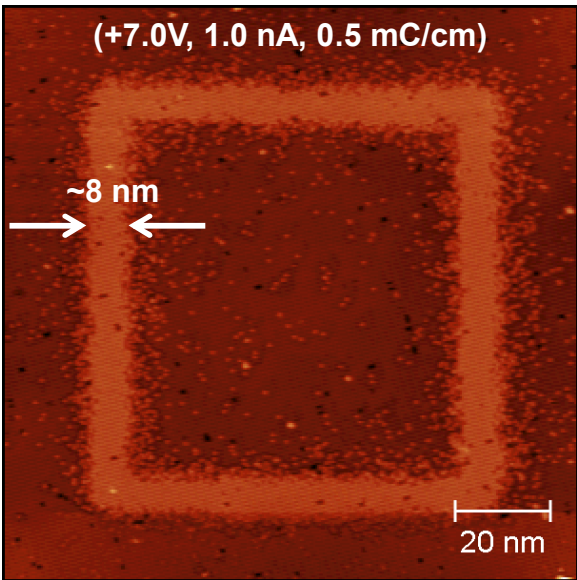
Two H Desorption Mechanisms



Avouris, *Chem. Phys. Lett.*, 257 (1996)

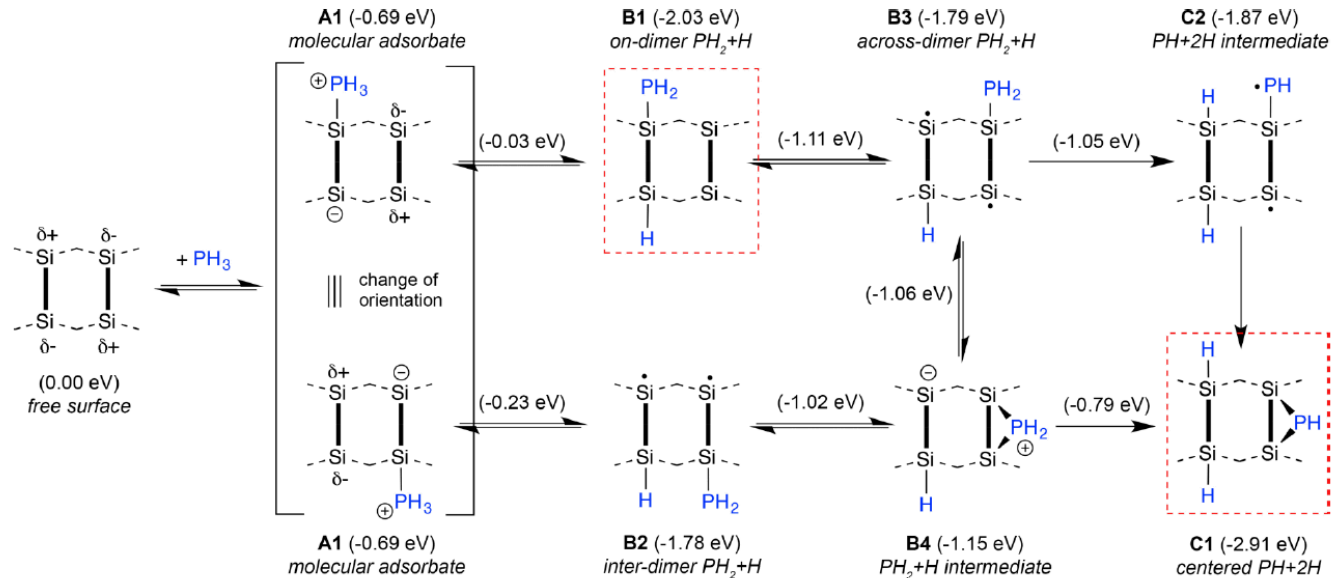
Multi-electron stochastic process

Tune pattern size with (V, I, dose) conditions



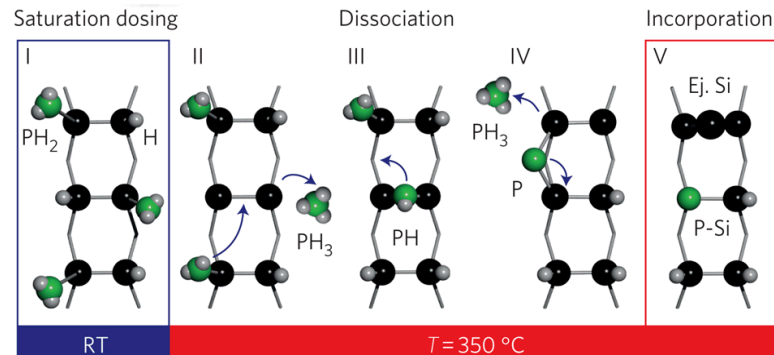
P Donor Incorporation Mechanism

Adsorption and Dissociation of PH_3 on Si(100)



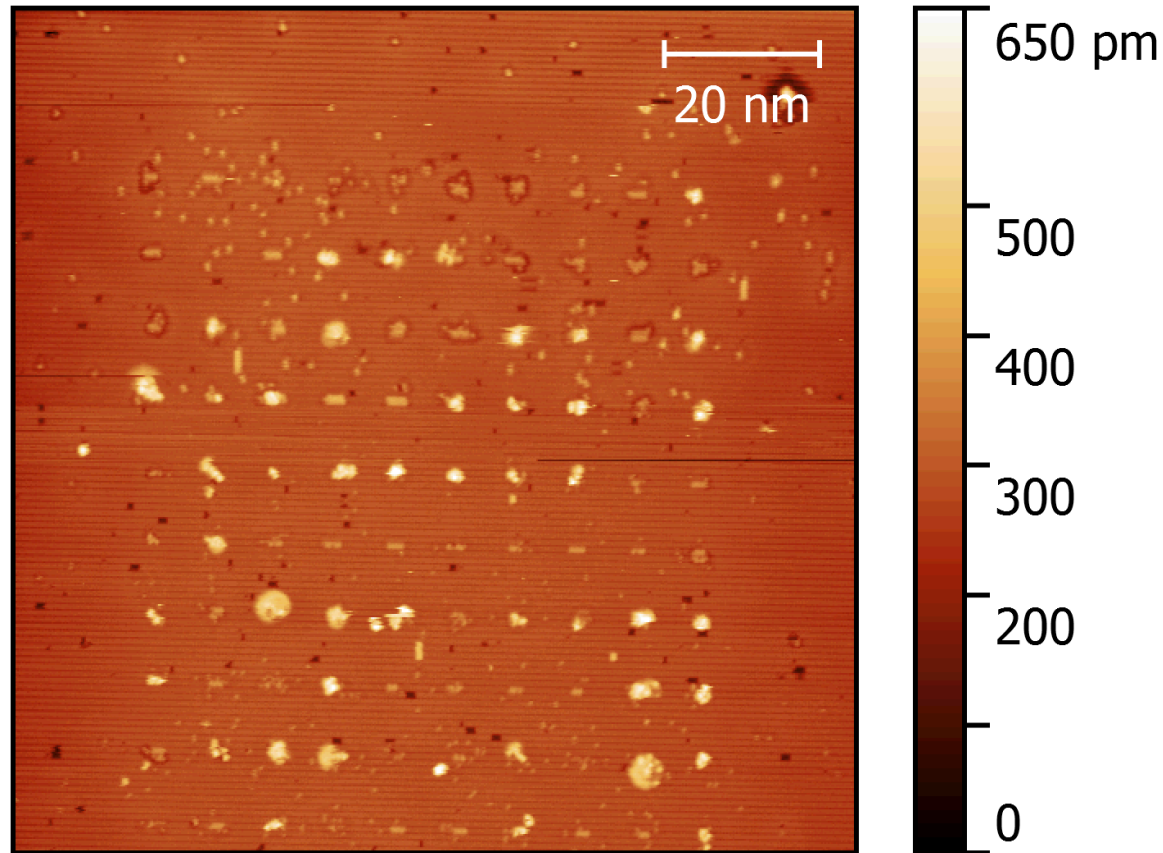
Warschcow, *J. Chem. Phys.*, 144 (2016)

Route to single P donor incorporation



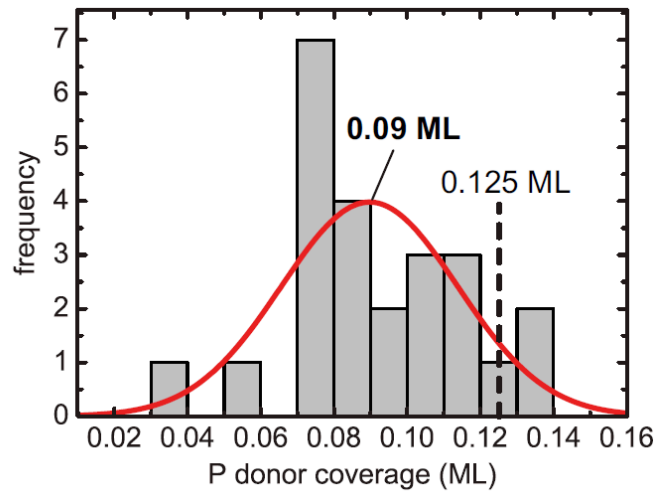
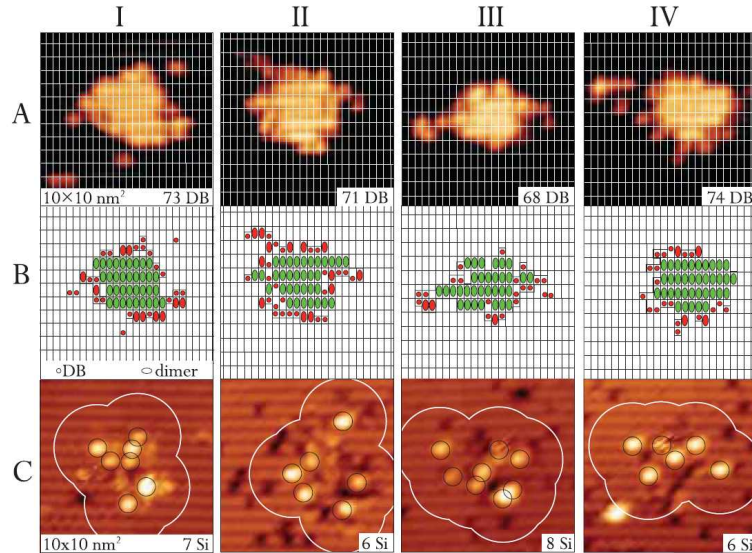
Fuechsle, *Nat. Nano.*, 7 (2012)

Lithographic Arrays – Tip Limitations

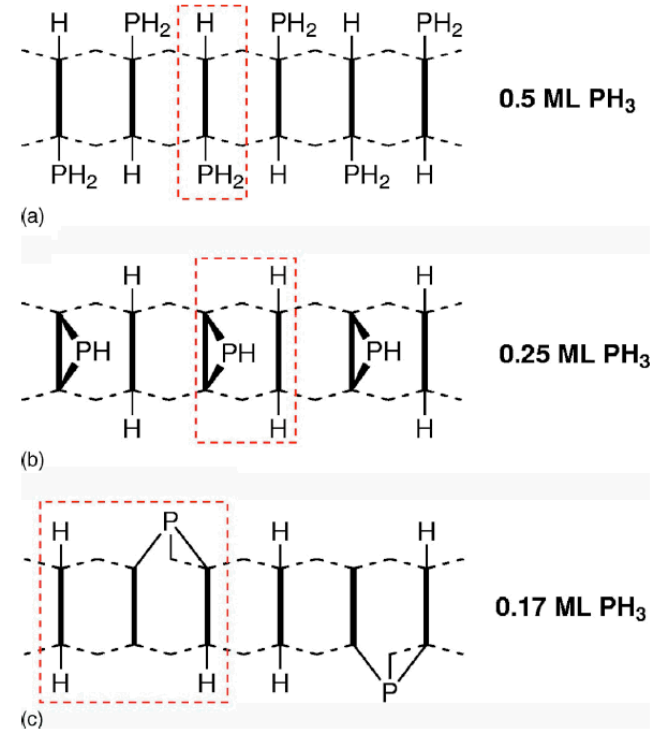


Tip limitations: drops material, apex changes leading to misalignment, apex modifications alter conditions for successful writing.

Donor Yield in Small Lithographic Boxes



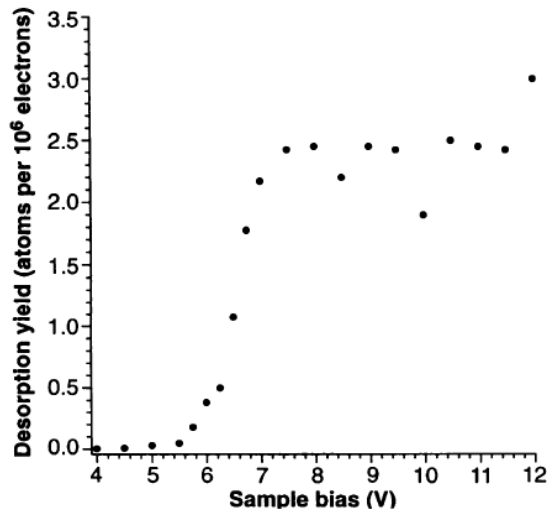
Fuechsle, *Ph.D. Dissertation* (2011)



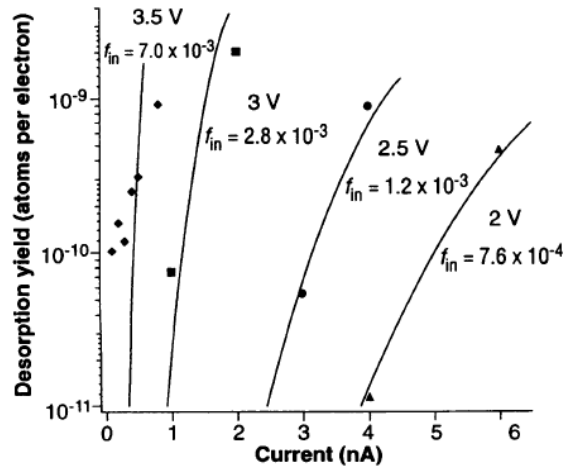
Wilson, *Phys. Rev. B*, 74 (2006)

STM Hydrogen Lithography Mechanisms

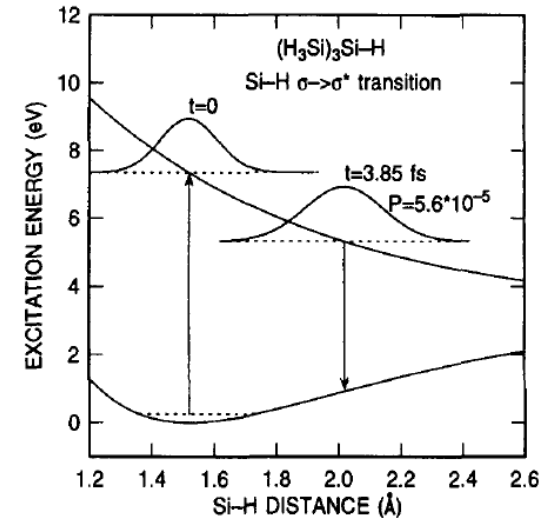
Bias/Current Dependence of H Desorption Yield



Shen, *Science*, 268 (1995)

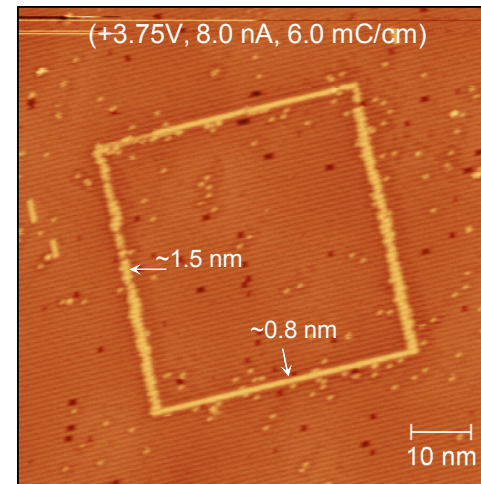
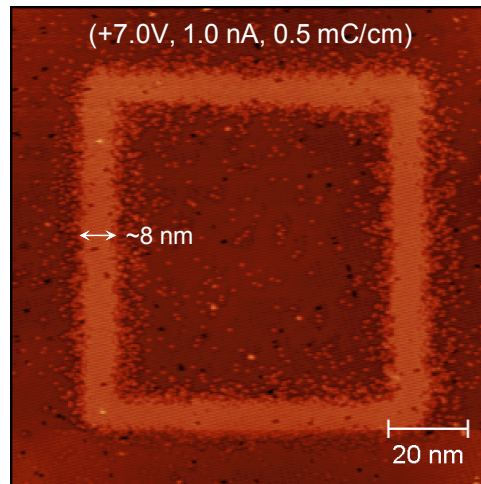


Two H Desorption Mechanisms



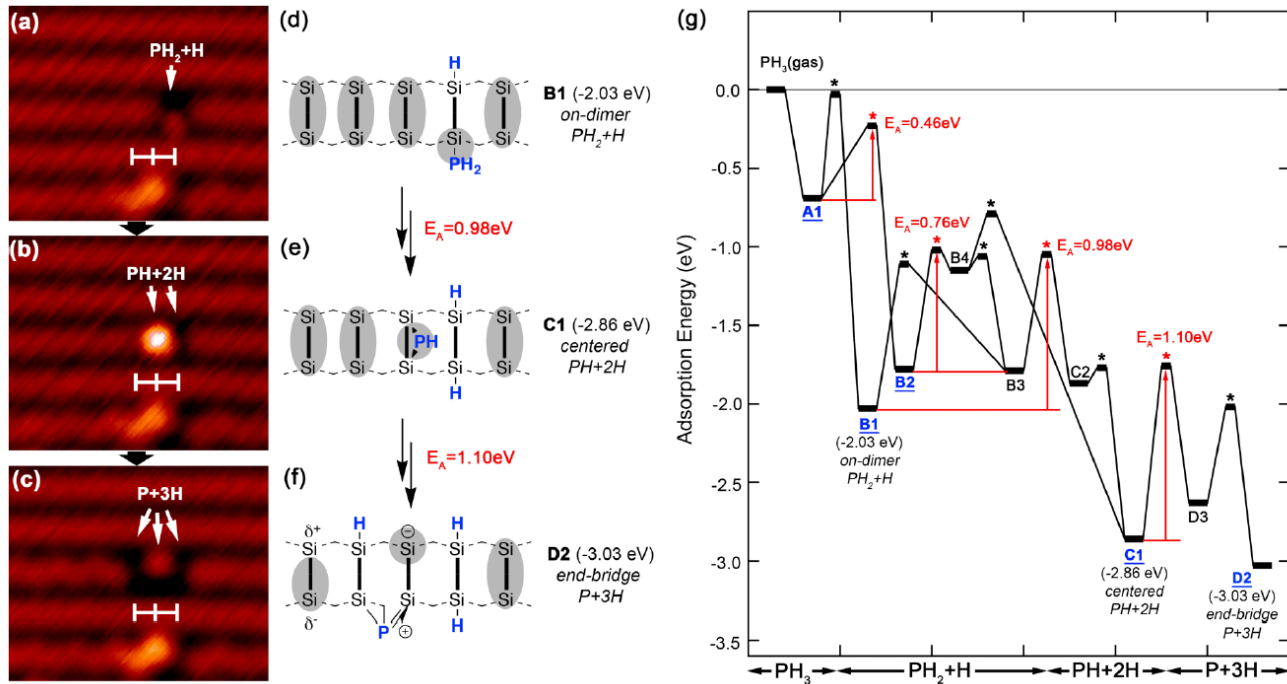
Avouris, *Chem. Phys. Lett.*, 257 (1996)

Two Patterning Fidelity Regimes



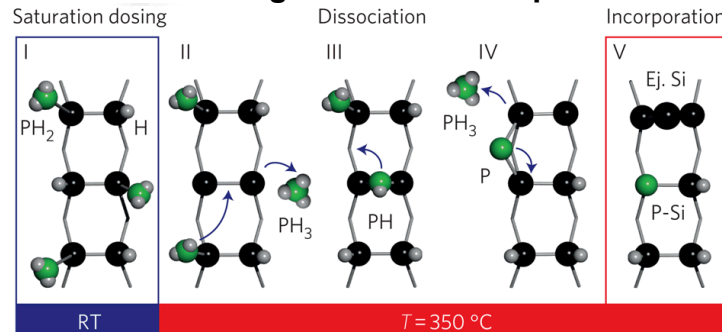
P Donor Incorporation Mechanism

Adsorption and Dissociation of PH_3 on Si(100)



Warschkow, *J. Chem. Phys.*, 144 (2016)

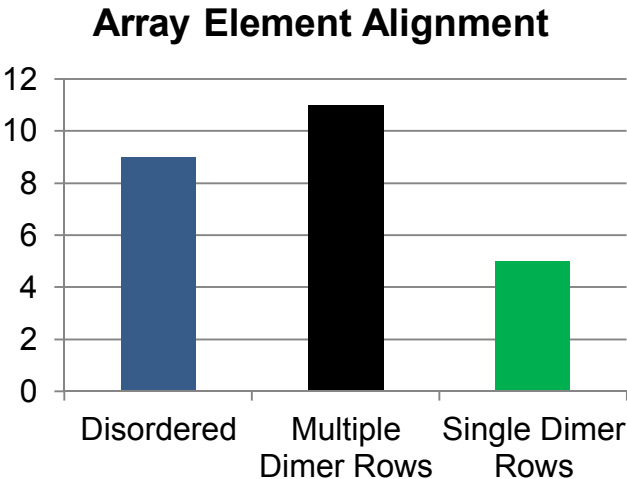
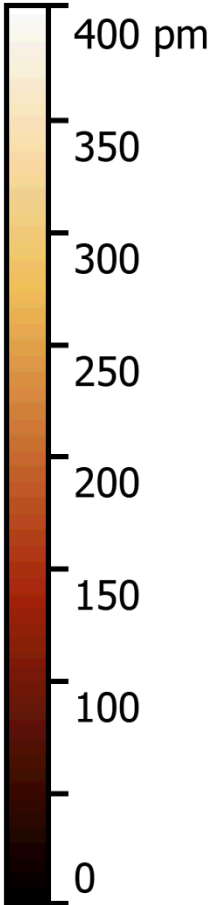
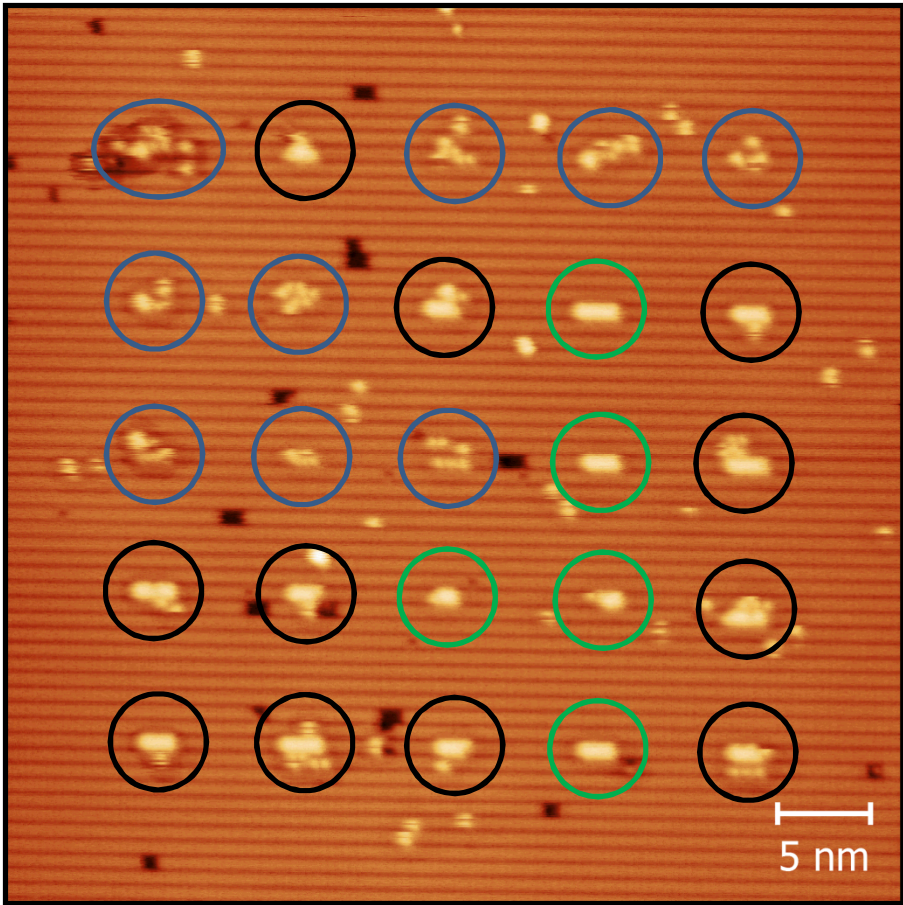
Route to single P donor incorporation



Fuechsle, *Nat. Nano.*, 7 (2012)

Lithographic Arrays – Alignment

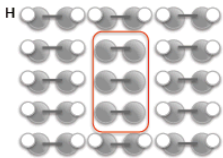
5x5 Litho Array Litho Parameters:
(+2.75 V, 15.0 nA, 10.0 mC/cm, 15 nm/s)



Single Dimer Row Yield: 5/25

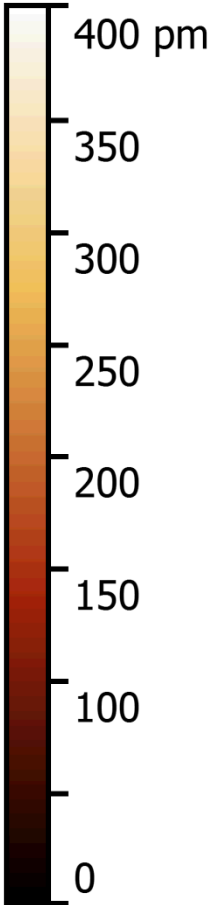
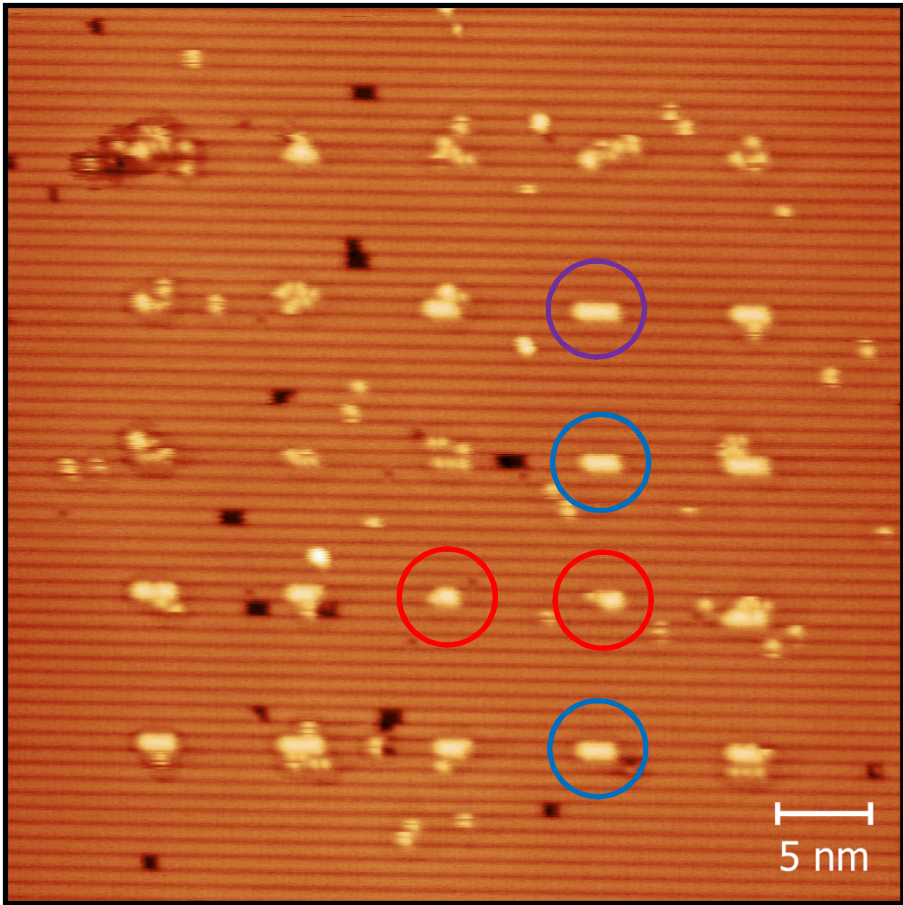
Disordered Features
Multiple Dimer Row Features
Single Dimer Row Features

Target Litho Array
Element: 1x3 Dimers

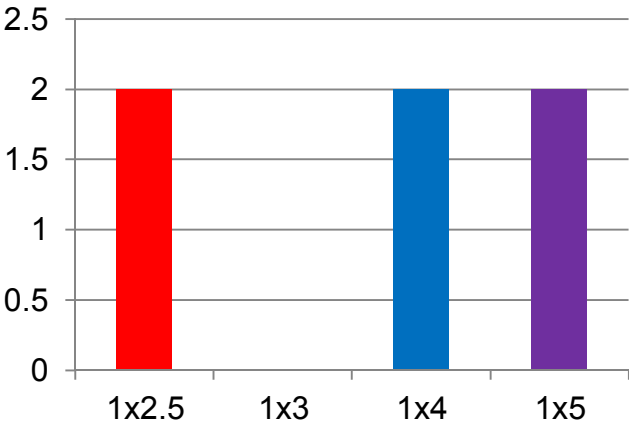


Lithographic Arrays – Pattern Length

5x5 Litho Array Litho Parameters:
(+2.75 V, 15.0 nA, 10.0 mC/cm, 15 nm/s)



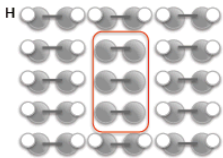
Single Dimer Row Pattern Length (Dimers)



Yield of 1x3 Dimer Patterns: 0

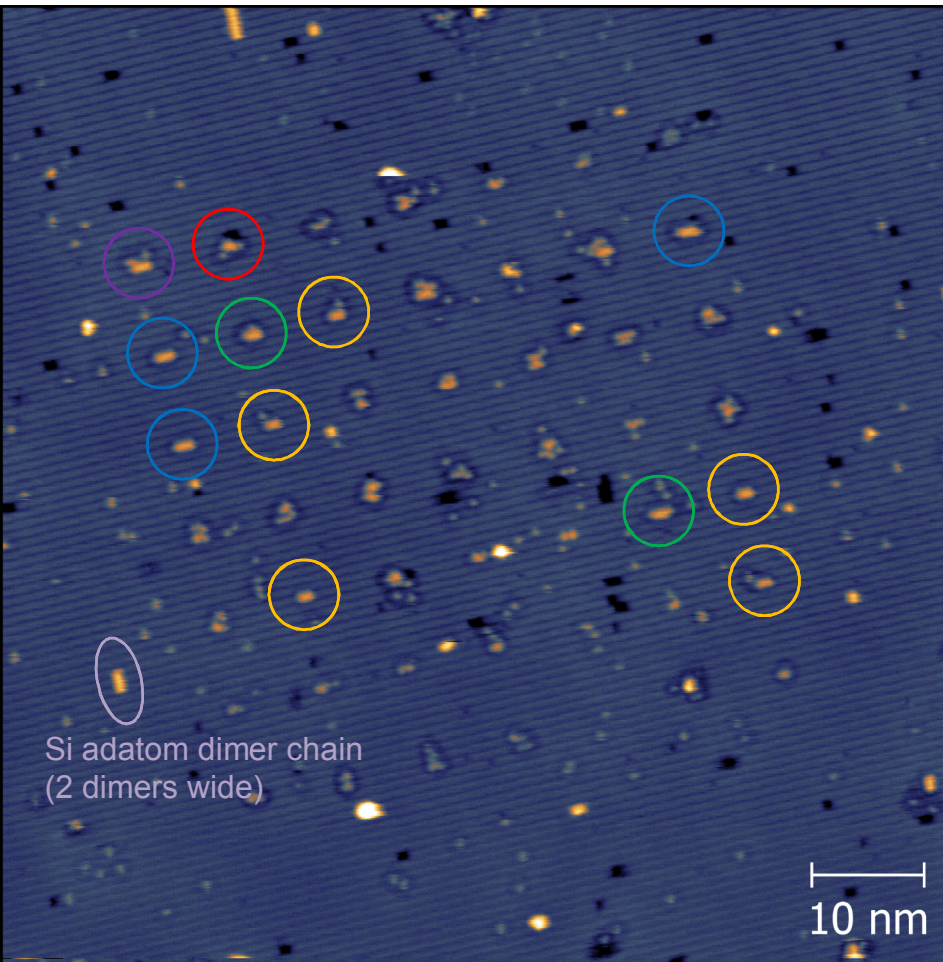
- 1x2.5 Dimers
- 1x3 Dimers
- 1x4 Dimers
- 1x5 Dimers

Target Litho Array
Element: 1x3 Dimers

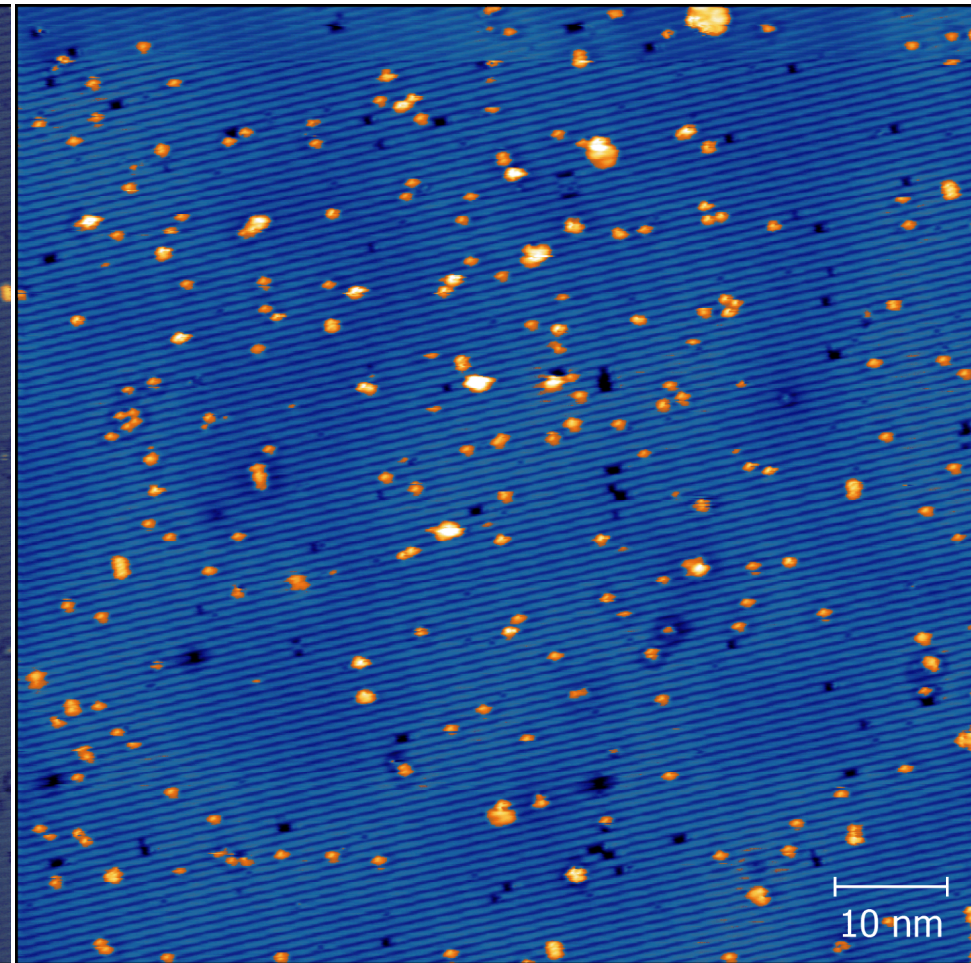


P Donor Incorporation in Lithographic Arrays

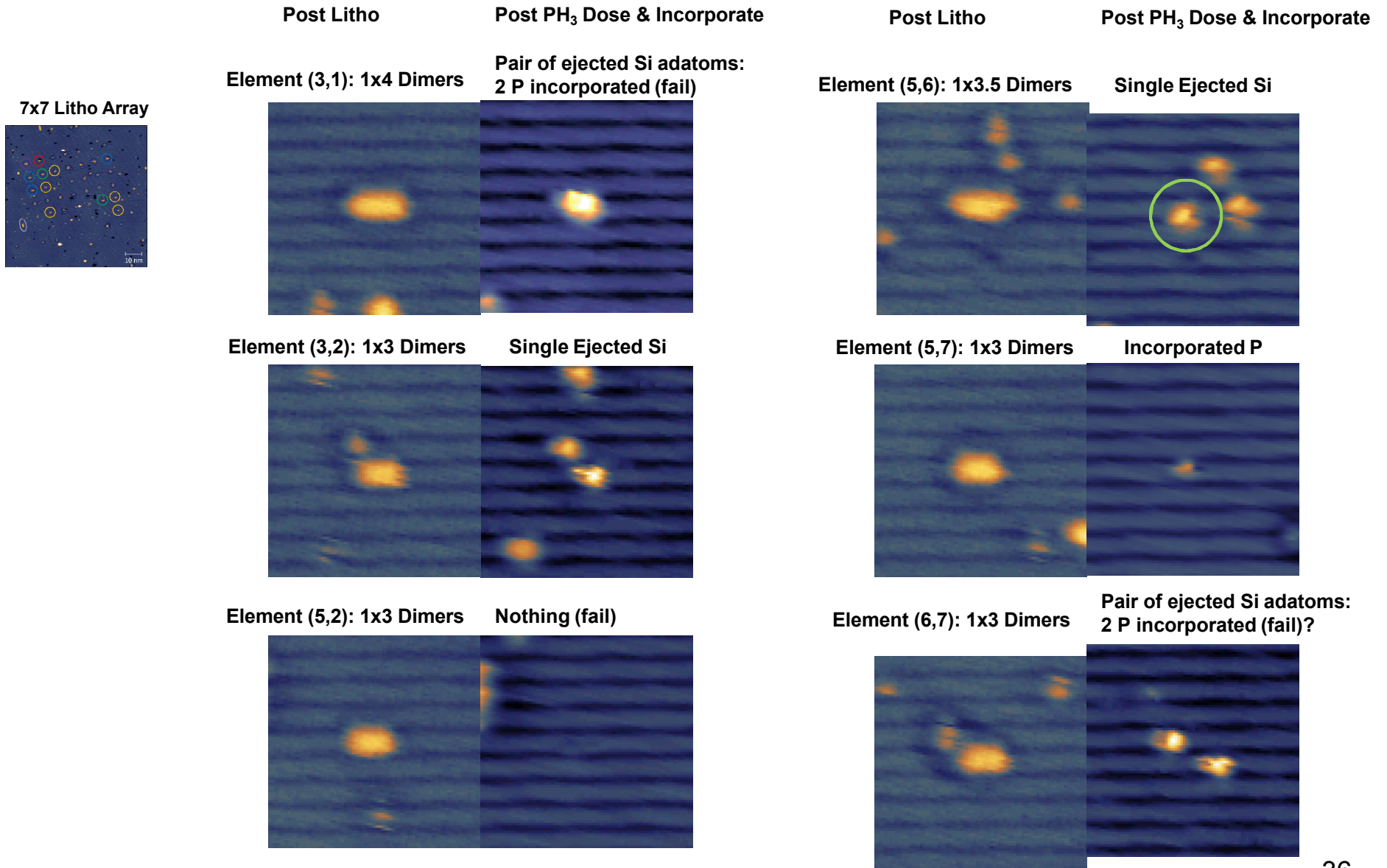
7x7 Lithographic Array



After PH_3 Dose and Incorporation

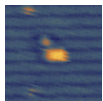


P Donor Incorporation in Lithographic Arrays



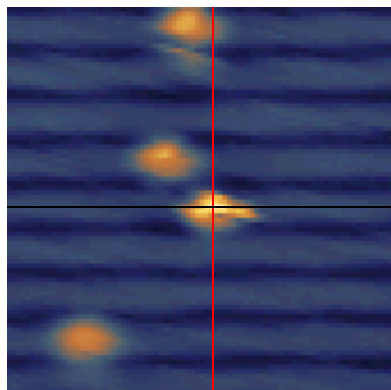
P Donor Incorporation in Lithographic Arrays

Post Litho, Pre-PH₃

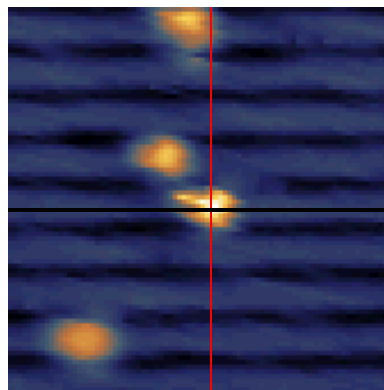


Array Element (3,2) – 1x3 dimers

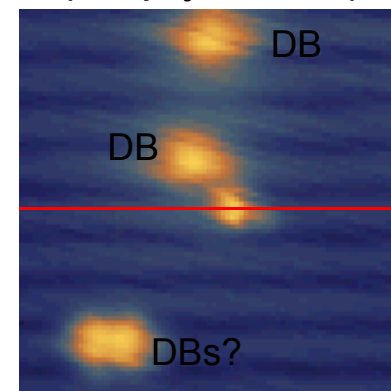
Post-PH₃ Incorporation
(filled states), trace



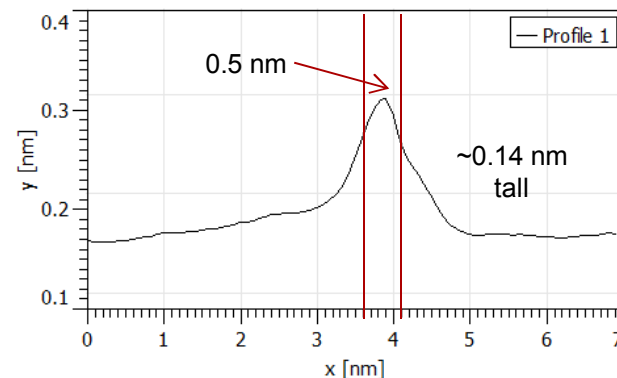
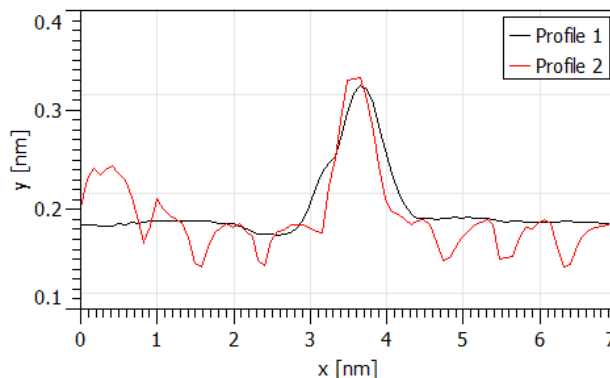
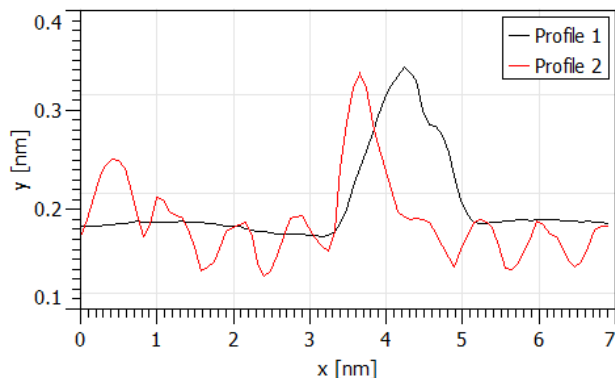
Post-PH₃ Incorporation
(filled states), re-trace



Post-PH₃ Incorporation
(empty states)



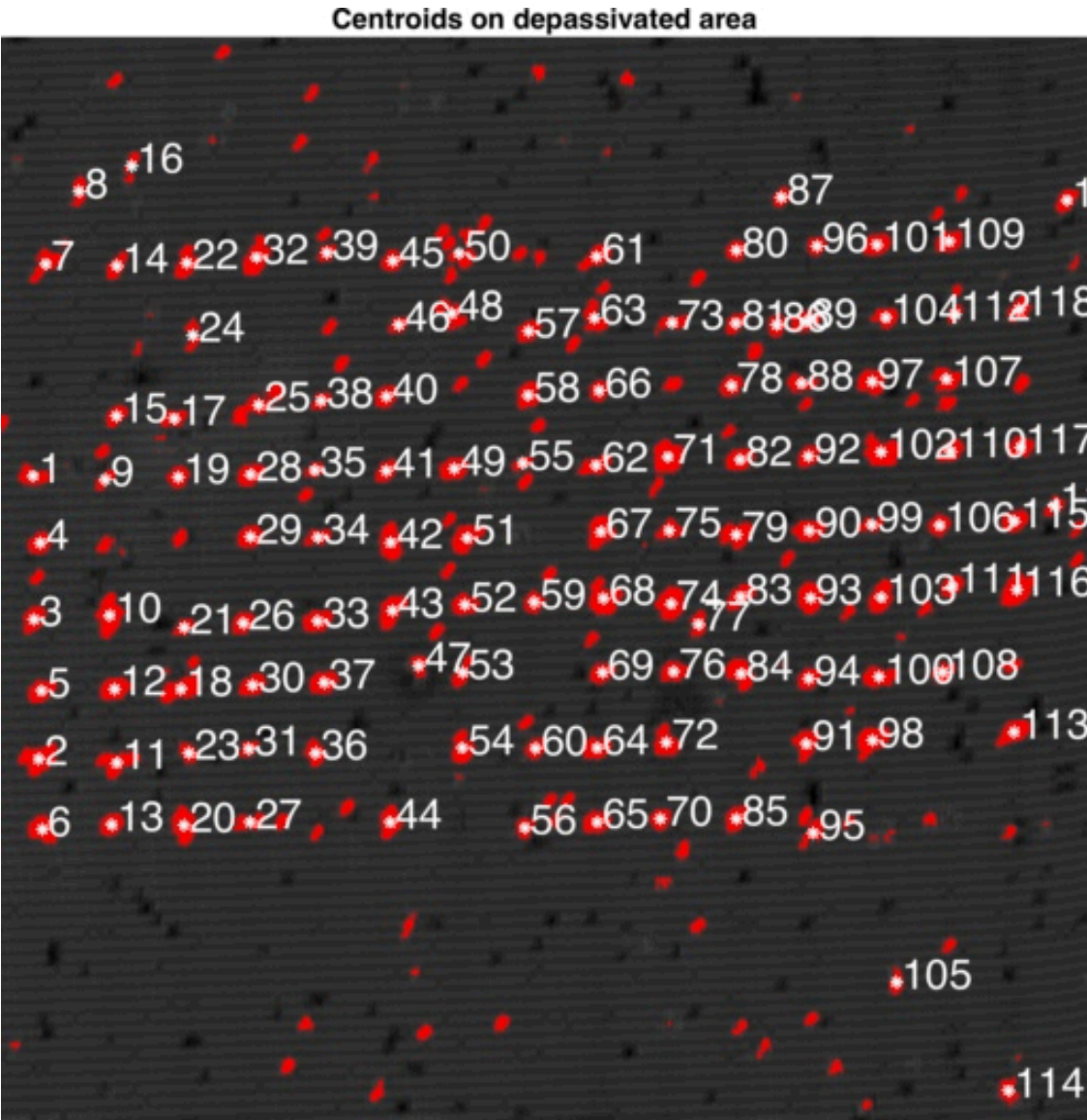
Single ejected Si atom



Along dimer row cross section:
~0.165 nm tall and ~0.67 nm wide
Across dimer row cross section:
~0.166 nm tall and ~0.39 nm wide

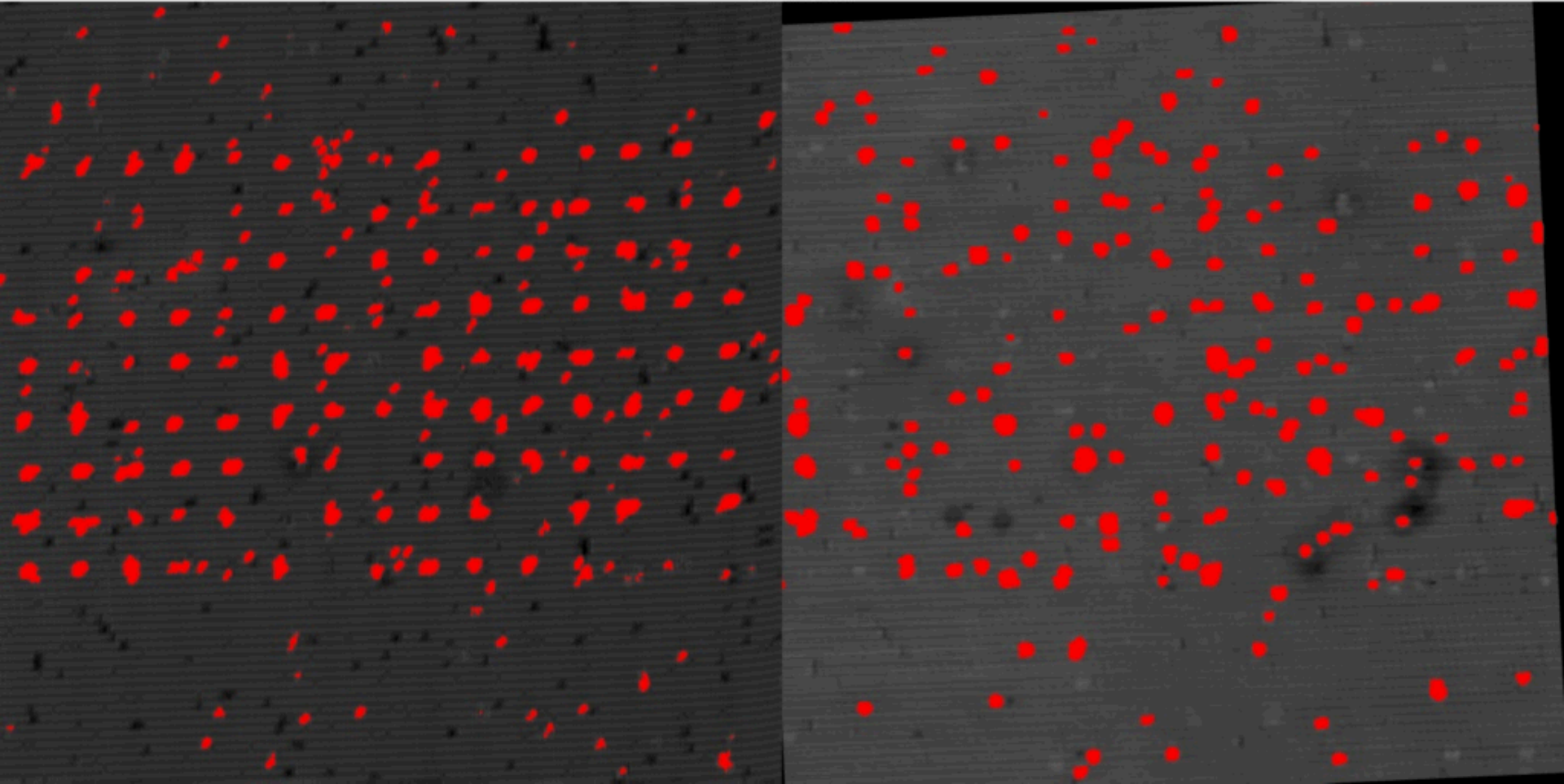
Along dimer row cross section:
~0.150 nm tall and ~0.51 nm wide
Across dimer row cross section:
~0.169 nm tall and ~0.46 nm wide

Feature Identification for Array Analysis



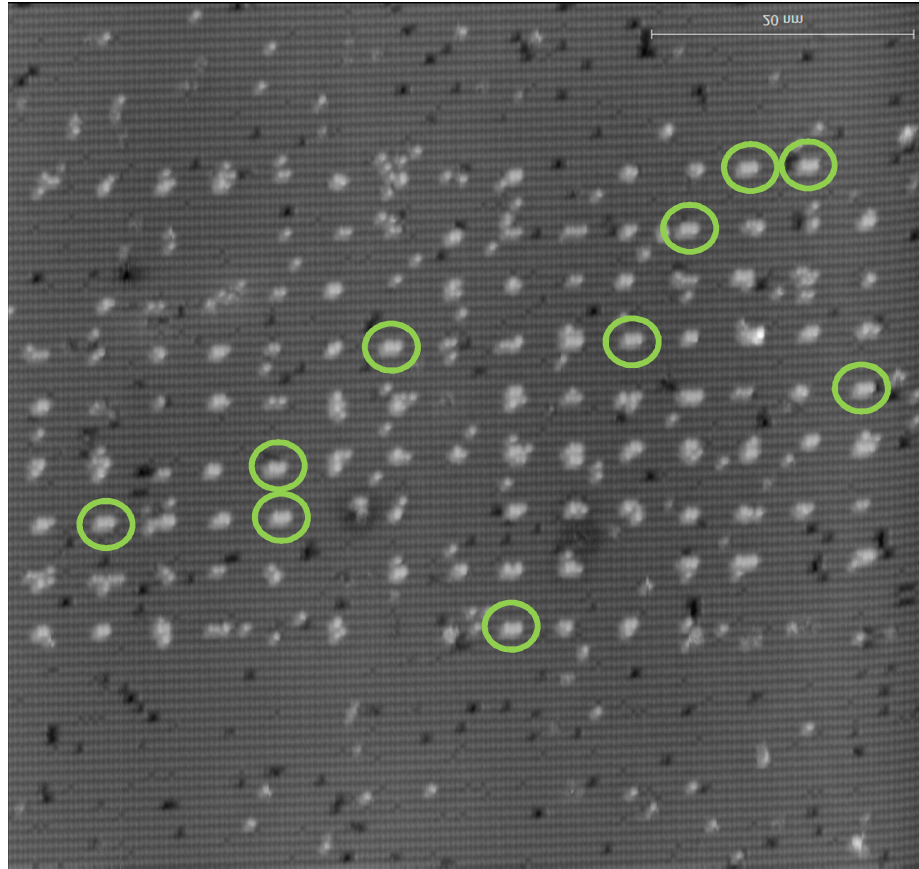
Feature Identification for Array Analysis

Found features

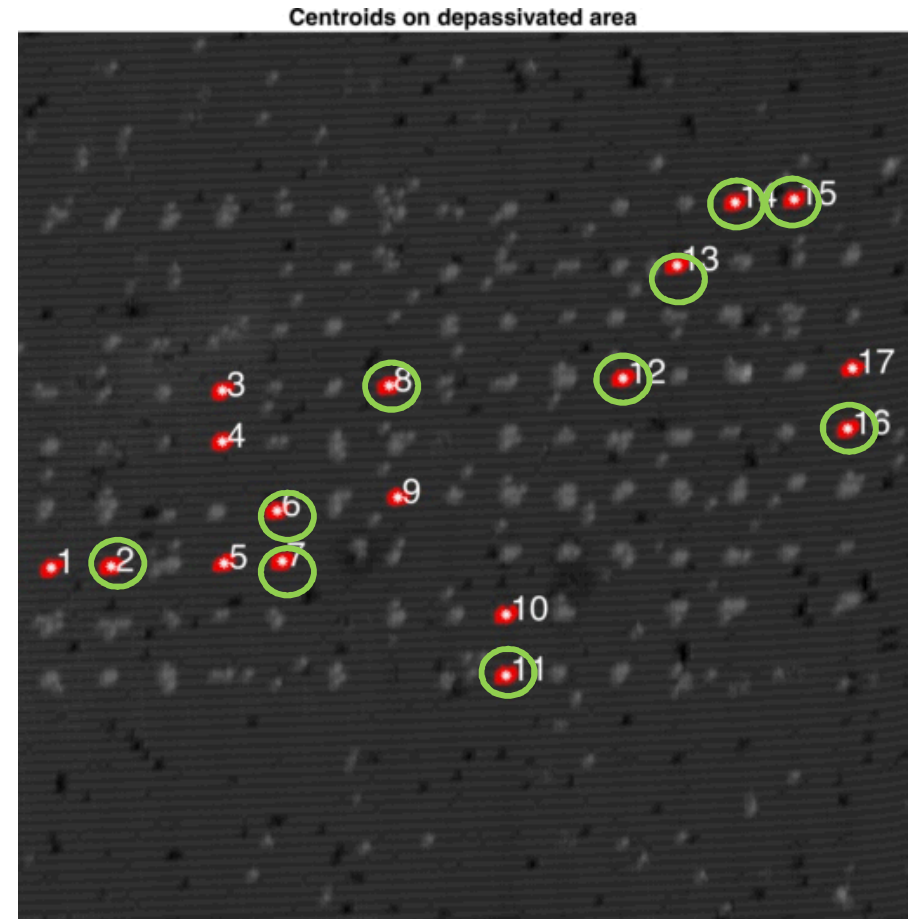


Feature Identification for Array Analysis

Now refind regions using data from successes (minor/major axis + area)



10 areas



All 10 real area / Total of 17 areas